

TowerJazz Investor and Analyst Day



Welcome and Introductions

Noit Levy-Karoubi | Vice President of Investor Relations

Disclaimers

Forward Looking Statements

This presentation contains forward-looking statements within the meaning of the "safe harbor" provisions of the Private Securities Litigation Reform Act of 1995. These statements are based on management's current expectations and beliefs and are subject to a number of risks, uncertainties and assumptions that could cause actual results to differ materially from those described in the forward-looking statements. All statements other than statements of historical fact are statements that could be deemed forward-looking statements. For example, statements of expected synergies from Tower's merger with Jazz, customer benefits, costs savings, financial guidance, industry ranking, execution of integration plans and management and organizational structure are all forward-looking statements. The potential risks and uncertainties include, among others, that expected customer benefits, synergies and costs savings will not be achieved or that the companies are unable to successfully execute their integration strategies, as well as other risks applicable to both Tower and Jazz's business described in the reports filed by Tower and Jazz with the Securities and Exchange Commission (the "SEC") and, in the case of Tower, the Israel Securities Authority. These filings identify and address other important factors that could cause Tower and Jazz's respective financial and operational results to differ materially from those contained in the forward-looking statements set forth in this document. Accordingly, no assurances can be given that any of the events anticipated by the forward-looking statements will transpire or occur, or if any of them do so, what impact they will have on the results of operations or financial condition of Tower or Jazz. Tower and Jazz are providing this information as of the date of this presentation and neither Tower nor Jazz undertakes any obligation to update any forward-looking statements contained in this document as a result of new information, future events or otherwise.

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Agenda

8:00-8:30am	Registration + Continental Breakfast	
8:30-8:35am	Welcome and introductions	Noit Levy-Karoubi
8:35-9:00am	CEO Opening	Russell Ellwanger
09:00-09:40am	Strategic Overview - Main Focuses and Growth Opportunities	Dr. Itzhak Edrei
09:40-10:10am	Financial performance and strategy	Oren Shirazi
10:10-10:30am	AM break	
10:30-11:00am	Specialty Technology Offering and Growth Drivers: RF	Dr. Marco Racanelli
11:00-11:30am	Specialty Technology Offering and Growth Drivers: PM	Dr. Marco Racanelli
11:30am-12:00pm	Specialty Technology Offering and Growth Drivers: CIS	Dr. Avi Strum
12:00-12:30pm	Q&A	
12:30-1:15pm	Lunch Break	
1:15-1:30pm	Transportation to SA Facility	
1:30-2:00pm	Worldwide Operational Overview	Rafi Mor
2:00-2:15pm	CEO Summary	Russell Ellwanger
2:15-3:15pm	Fab Tour – Introduction and entering the fab	Rafi Mor
3:15pm	Closing	



Our Leadership Team | TowerJazz Management



MR. RUSSELL ELLWANGER Chief Executive Officer Chairman, TPSCo



DR. ITZHAK EDREI President



MR. RAFI MOR Chief Operating Officer



MR. OREN SHIRAZI Chief Financial Officer Senior Vice President of Finance



MRS. DALIT DAHAN
Senior Vice President of Human
Resources and Information
Technology



MRS. NATI SOMEKH Senior Vice President, Chief Legal Officer and Corporate Secretary



MR. YOSSI NETZER Senior Vice President of Corporate Planning



MR. ILAN RABINOVICH
Vice President of Quality and
Reliability and Vice President of
Customer Support



Our Leadership Team | Business Units and Sales



DR. MARCO RACANELLI

Senior Vice President and General Manager of RF/ High Performance Analog and Power Business Groups

General Manager of US Aerospace & Defense Business Group, Newport Beach Site Manager



DR. AVI STRUM

Senior Vice President and General Manager, CMOS Image Sensor Business Unit



MR. SHIMON GREENBERG

Vice President of Mixed-Signal/CMOS Business Unit



MRS. ZMIRA SHTERNFELD-LAVIE

Senior Vice President of Process Engineering R&D

General Manager of Transfer, Optimization and Development Process Services Business Unit (TOPSTM)



MR. ORI GALZUR

Vice President of VLSI
Design Center and Design
Enablement



MR. GARY SAUNDERS

Senior Vice President of Worldwide Sales & General Manager, TowerUSA



MR. TODD MAHLEN

Vice President of Asia Pacific Sales and China Business Development



MR. DANI ASHKENAZI

Vice President of Sales for Israel & Europe and Vice President of Customer Solutions



MR. MICHAEL SONG

Vice President of Sales and President of TowerJazz Korea



MR. FRA DRUMM

Vice President of Business Development, USA





TowerJazz Investor and Analyst Day



CEO Opening

Russell Ellwanger | CEO

Big Picture - What Drives Success?

2 things:

-Vision

The vision dictates what skills are required in the staff

-Staffing

The proper staff enables vision to be fulfilled and to evolve



Alice in Wonderland | Lewis Carroll

Alice approaching a crossroad, asked the Cheshire Cat

Alice: "can you please tell me which way I ought to go from here?"

Cat: "that depends a good deal on where you want to get to"

Alice: "I don't much care where"

Cat: "then it doesn't much matter which way you

go..."



Vision, Mission, Values

Our Vision

 To be the world leader in specialty foundry solutions as measured by our customers, employees and investors.

Our Mission

 To bring to market specialty foundry solutions that provide unique value to our customers by attentively listening to and proactively providing for their needs, through attracting and retaining the best global talent to serve them.

Our Values

- Embrace a Customer Centric Mentality
- Knowledge, Skills and Attitude, Focused on Collaboration and Innovation
- Data Driven and Results Oriented
- Foster a Culture Built on Mutual Trust and Respect
- Demand Quality and Excellence in Everything We Do



First Set of Strategies (2005-2008)

- We had a non servable debt structure and a Fab2 operational capacity that could not create cash positive
 - Show growth
 - Achieve financial milestones
 - → Gain market confidence
 - → Raise money/ restructure debt



2005 Status

Financials	2005
Revenues \$M	100
Net Debt \$M (exc. In the money converts)	550

Operations	2005
# of Fabs	2
Locations	1
Capacity KWPY	290
Employees	900
Customers	~30 (4 in F2)



Accountable vs. Victim

Get On with It 8 Accountable **Find Improvements, Solutions** 6 **Own It – Take Responsibility** 5 **Acknowledge Reality – Get the Data** 4 **Wait and Hope Things Get Better** 3 **Make Personal Excuses Blame Others Unaware There's a Problem**



What did we do? (1) STRUCTURE

- We reinvented ourselves to be a customer centric company
- Decentralized "core" capabilities to viable profit centers
 - Eliminated central R&D
 - Created Product-Lines with business owners controlling R&D, customer support and marketing

Restructured organization to give "local" empowerment;

Learned to fight the tendency of efficiency through centralization



Adizes quote

"The way you are structured, it's easier to pee in your pants than to get to the bathroom" (at least you have momentary warmth)



What did we do? (2) TARGETS

Set, communicated and celebrated aggressive but achievable targets:

Q4'05 positive EBITDA Achieved

Opened a new cafeteria Achieved 1

- Q4'06 positive CF

Corporate celebration

"Clear, simple messages energize people and inspire them to action, thus simplicity leads to speed, one of the key drivers of business success" (J.Welch, GE 2000 Annual report)



What did we do? (3) PEOPLE

- "Do not spend your time on your poor performers
 - If they hurt you fire them; if not wait for the next layoffs
- Do not spend your time on average performers
 - If you do you will only have an average group
- Do not spend personal time even on your good performers
 - If you do you will only have a good group
- Identify your STARS:
 - Spend all your time on them, give them big opportunities and high visibility

You will then have a group of stars."

Jim Morgan, AMAT



Second Set of Strategies/tactics (2008 – 2010)

- Become analog leader
- Break \$500M revenue

- Jazz merger became TowerJazz
 - Entered RF, expanded our technology offering
 - Fortified business units
 - Reduce company cost through consolidation and high utilization rates



Foundry Landscape

(\$M)	20	05	20	10	20	15	Accumulated Growth
А	TSMC	8,217	TSMC	13,307	TSMC	26,439	222%
В	UMC	3,259	UMC	3,965	GlobalFoundries	4,990	341%
С	SMIC	1,171	GlobalFoundries	3,510	UMC	4,464	37%
D	PowerChip	1,587	PowerChip	2,424	SMIC	2,222	90%
Е	Chartered	1,132	SMIC	1,555	PowerChip	1,268	-20%
1	Vanguard	353	TowerJazz	509	TowerJazz	961	842%
2	Dongbu	347	Vanguard	505	Vanguard	736	108%
3	HHNEC	313	Dongbu	495	Hua Hong Semi	650	108%
4	SSMC	280	SSMC	330	Dongbu HiTek	585	69%
5	He Jian	250	X-Fab	320	SSMC	460	64%
11	Tower	102					

Digital Deep Sub Micron

Specialty Analog

Source: IC Insights, EE Times, Company Reports

The fastest growing foundry in the world



TowerJazz Business Units – Specialty Technology Leader



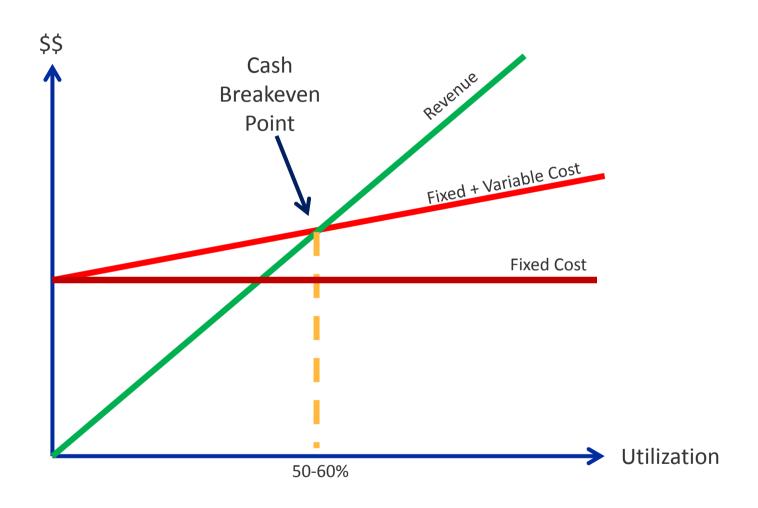


Third Set of Strategies/ tactics (2011–2015)

- Business and operational model enabling sustainable
 GAAP net profit
 - Strong strategic alignment with first tier customers on multi generation roadmaps
 - Acquire large capacity at very low cost with little to no running cost to be absorbed by TowerJazz

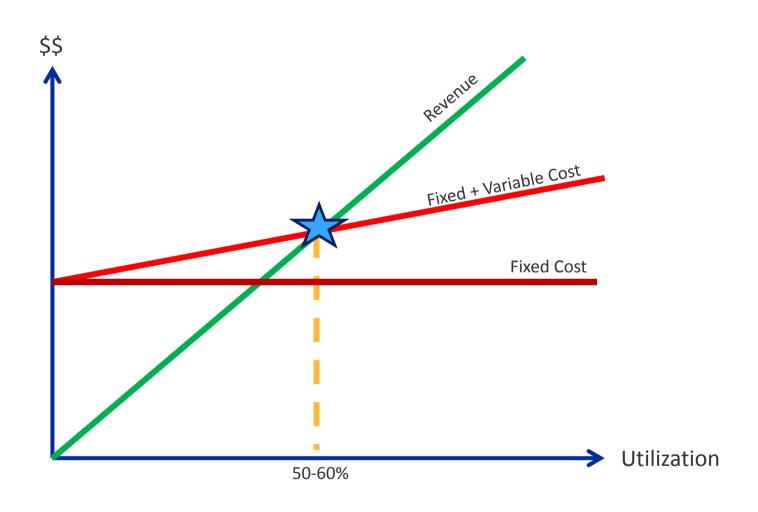


Low cost, low risk, WIN WIN capacity acquisition





Low cost, low risk, WIN WIN capacity acquisition



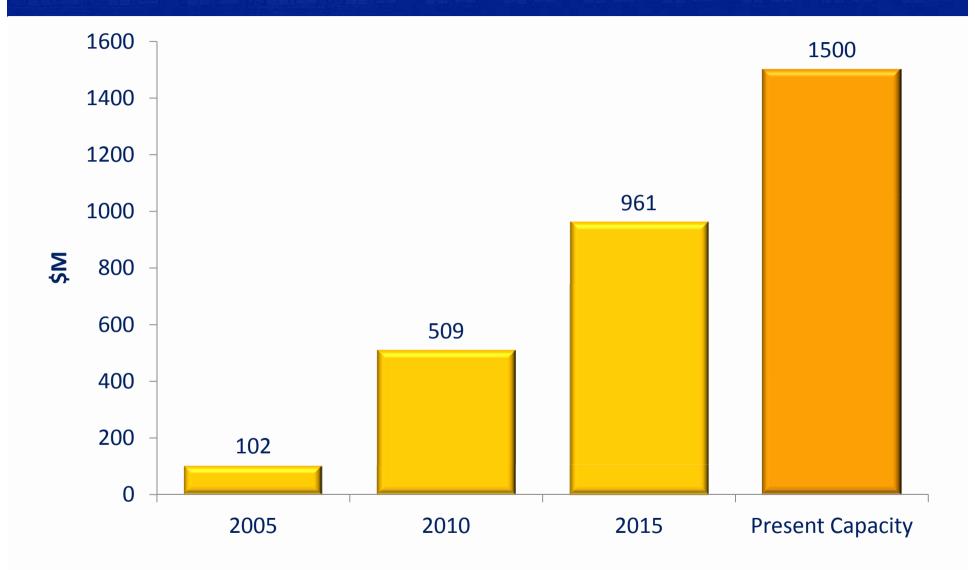


Third Set of Strategies/tactics (2011–2015)

- Business and operational model enabling sustainable
 GAAP net profit
 - Strong strategic alignment with first tier customers on multi generation roadmaps
 - Acquire large capacity at very low cost with little to no running cost to be absorbed by TowerJazz
- TPSCo: ~ \$2B contract and 500k-600k wpy open capacity
- San Antonio: 15 years supply contract, ~ 150k WPY free capacity



Annual Revenues





10 Year Anniversary

Financials	2005	Present Run Rate
Revenues \$M	100	>1,000
Net Debt \$M (exc. In the money converts)	550	48

Operations	2005	Present Run Rate
# of Fabs	2	7
Locations	1	3 continents/ 6 locations
Capacity KWPY	290	2,350
Employees	900	4,500
Customers	~30	>300



Corporate Targets



Corporate Financial Targets 2016

- Revenue:
 - Target: growth throughout the year
- Continue to improve the margins across the board
 - 1-2 points negative first year impact of TJT (San Antonio fab)
 on margin percent but positive on all cash indices
 - Target:
 - GAAP operating margin from 8% for FY 2015 to double digit throughout 2016 with H2>H1



Focus: net profit 2016/2017

- Maintain and grow positive net profit
 - Achieved: Q2'15 \$8M \rightarrow Q3'15 \$14M \rightarrow Q4'15 \$22M
 - 2016 target: growth against Q4'15 annualized baseline
 - MH Fab2 capacity ramp at high utilization
 - NPB Fab3 realization of annualized capacity increase
 - TPSCo 3rd party revenues ramp to >\$25M/ quarter by EOY
 - 2017 target: additional growth
 - Fab2 realization of annualized capacity increase
 - Fab3 with higher margin mix
 - TPSCo 3rd party revenues increase to >\$50M/ quarter by EOY
 - TJT (San Antonio fab) revenue growth >25% 2017/16





TowerJazz Investor and Analyst Day



Strategic Overview
Main Focuses and Growth Opportunities

Dr. Itzhak Edrei | President

Outline

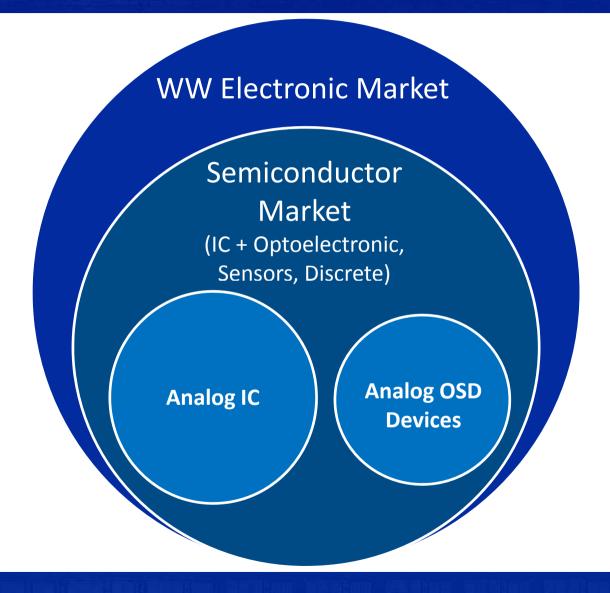
- The big picture and where we are
 - Macro-economics & semiconductor market trends
 - Worldwide IC Market
 - Analog IC Market
 - O-S-D Market
- Strategy: main focuses for profitable growth



The BIG Picture and Where We Are

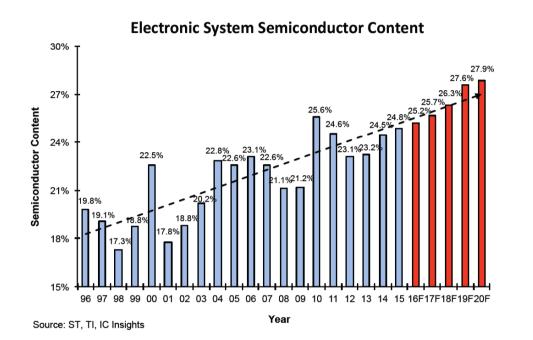


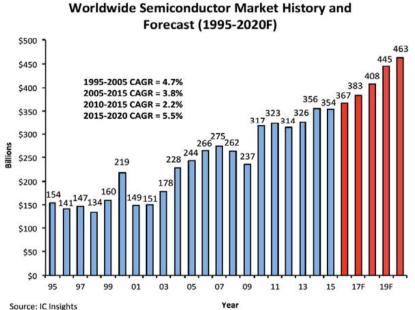
The Big Picture & where are we playing?





Increase value of semiconductor





Percent of dollar content in electronic systems is increasing

There is an increasing value of semiconductors used in electronic systems



Total IC and O-S-D Markets

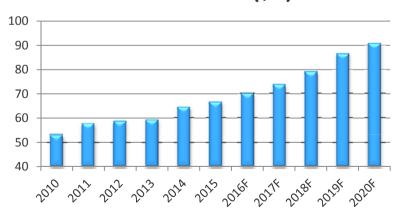
Integrated Circuits (std logic, analog, memory)

2015 Breakdown

400
350
Memory
\$72B
250
200
Analog
150
\$47B
\$168B

Optoelectronics (CIS)
Sensors/ Actuators
Discrete

O-S-D Market (\$B)



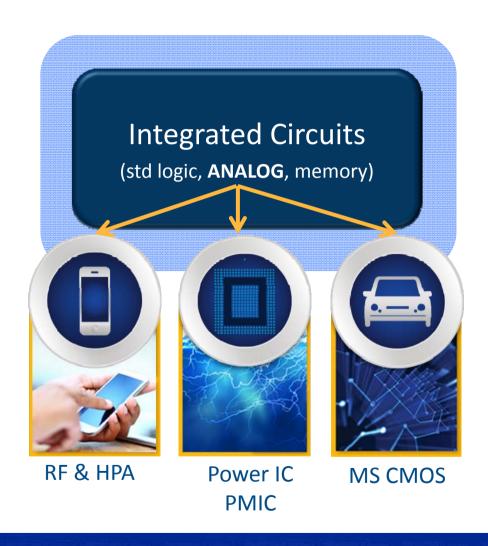


TowerJazz Business Units — Specialty Technology Leader





IC and O-S-D Markets



Optoelectronics (CIS)
Sensors/ Actuators
Discrete



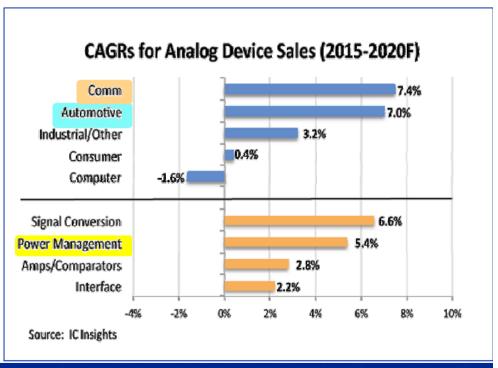
Analog markets by revenue and growth percent

2016 Analog IC Sales Forecast

	Market	% of Total	16/15
General Purpose Analog	(\$M)	Analog	% Chg
Amplifiers & Comparators	2,914	6.0%	2%
Interface	2,042	4.2%	1%
Power Management	11,785	24.1%	4%
Signal Conversion	3,205	6.5%	10%
Total General Purpose Analog	19,946	40.7%	4%

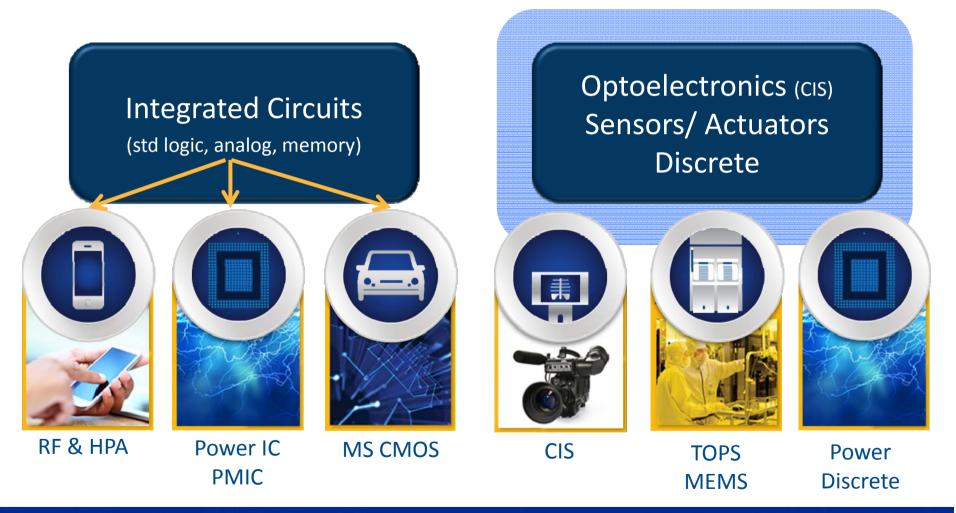
Application-Specific Analog	Market (\$M)	% of Total	16/15 % Chg
Consumer	1,845	3.8%	-2%
Computer	2,088	4.3%	-4%
Comm	15,760	32.2%	6%
Automotive	7,059	14.4%	5%
Industrial/Other	2,264	4.6%	2%
Total Application-Specific Analog	29,016	59.3%	4%
Total Analog Market	48,962	100.0%	4%

Source: IC Insights



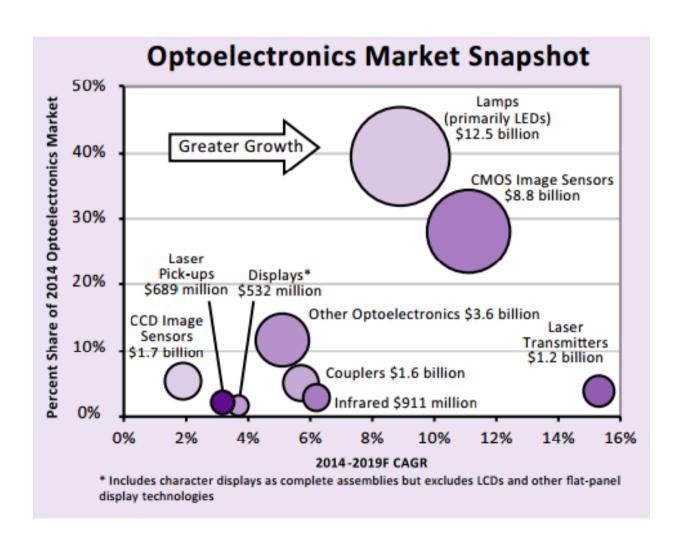


IC and O-S-D Markets





O-S-D Market Structure: Optoelectronics





O-S-D Market Structure: Sensors/ Actuators

Actuating applications Sensing applications Voice / Pressure Projecting / RF related Motion / **Emerging** Managing Sound position monitoring receiving Light functions fluids MEMS... Ink-jet MEMS Oscillators / u-Displays, Gyroscopes Silicon Micro- Pressure Resonators modules MEMS microphones mirrors -sensors Accelerometers RF-MEMS · Auto-focus switches Microfluidic & actuators TPMS Bio-chips modules Magnetometers · FBAR / BAW filters · IR sensing Fusion sensor combos & IMUs · SAW filters



Transfer Optimization and Develop Process Services



- Transferring process flows to TowerJazz fabs
- Researching and developing new processes



Our Target Customers

IDMs

- 'Fablight' outsourcing strategy
- Capacity shortage with internal fabs
- Double source policy
- Going through fab closure for cost reduction activities

Fabless Companies

- With process IP looking for manufacturing site
- Process was developed at R&D centers and will be transferred and optimized to production at TowerJazz fabs

Develop from R&D to Production

 Develop process IP, process module or flow in TowerJazz fabs



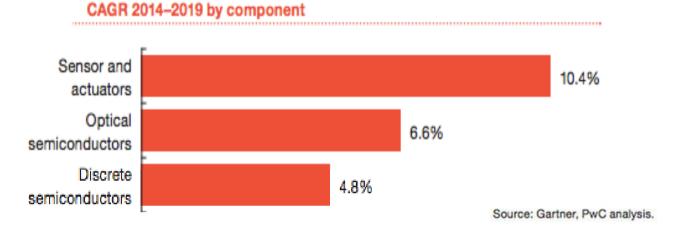
TOPS Business and Operational Strategy

- Most of our TOPS customers are under long term supply agreements
- Provide manufacturing stability
 - "guaranteed" percentage of fab fixed costs coverage
 - Assurance against industry cyclicality
- Among the customers: Infineon*, Siliconix,
 Fairchild and many others



^{*} Through acquisition of International Rectifier

O-S-D Market: Summary



Optoelectronics – expected to grow by a CAGR of 9% through 2019 mainly driven by LED and CIS.

Discrete – 383 Billion units shipped in 2014, growing use in portable devices for power managements, switching power supplies, battery charging. GaN/SiC – the next revolution?

Sensors & Actuators - MEMS are about 80% of \$ sales & 40% of the units. Market expected growth is driven mainly by IoT.



Regional Taxonomy



Global Footprint



San Jose, CA, USA Sales and Support Office



Migdal HaEmek, Israel 6" Fab and 8" Fab

Virginia, USA Sales and Support Office





Hsinchu, Taiwan Sales and Support Office



Seoul, South Korea Sales and Support Office

Nagaokakyo, Japan - TSJ Sales and Support Office

Tokyo, Japan Sales and Support Office



Newport Beach, CA, USA 8" Fab



San Antonio, TX, USA 8" Fab



Netanya, Israel Worldwide Design Center



Tonami, Japan 8" Fab



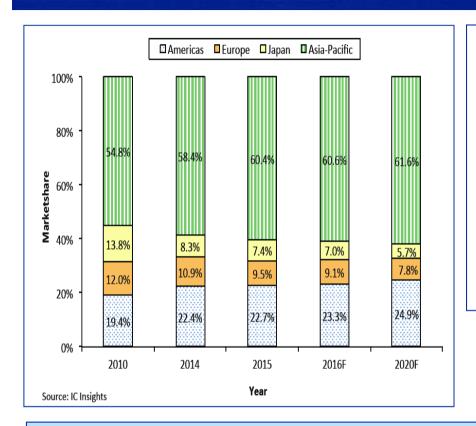
Uozu, Japan 12" Fab



Arai, Japan 8" Fab



Worldwide IC Market by Region



Asia-Pacific IC Market by Country (\$B)									
Region	2010	2014	2015	2016F	2017F	2018F	2019F	2020F	
China/Hong Kong	\$74.8	\$99.3	\$103.5	\$109.5	\$116.7	\$126.4	\$140.7	\$149.2	
Share of Total	52.3%	58.4%	59.7%	60.8%	61.9%	63.0%	64.0%	65.1%	
Taiwan	\$34.5	\$36.2	\$36.1	\$36.9	\$38.1	\$39.9	\$43.1	\$44.2	
Share of Total	24.1%	21.3%	20.8%	20.5%	20.2%	19.9%	19.6%	19.3%	
South Korea	\$15.4	\$16.2	\$16.0	\$16.0	\$16.2	\$16.7	\$17.6	\$17.6	
Share of Total	10.8%	9.5%	9.2%	8.9%	8.6%	8.3%	8.0%	7.7%	
Singapore	\$11.2	\$11.6	\$11.3	\$11.2	\$11.1	\$11.2	\$11.7	\$11.2	
Share of Total	7.8%	6.8%	6.5%	6.2%	5.9%	5.6%	5.3%	4.9%	
Other	\$7.2	\$6.8	\$6.6	\$6.5	\$6.4	\$6.4	\$6.8	\$6.9	
Share of Total	5.0%	4.0%	3.8%	3.6%	3.4%	3.2%	3.1%	3.0%	
Total Asia-Pacific	\$143.0	\$170.0	\$173.4	\$180.1	\$188.6	\$200.7	\$219.9	\$229.2	

Source: IC Insights

- Japan presence advantage for APAC manufacturing
- Sales focus in China, Taiwan, South Korea
- New initiatives in China (backed by government support)





Summary The BIG Picture



Worldwide IC and Analog Markets - Main Observations

- End Markets:
 - Communication, Power Management and Automotive are growing
- IC Market by Regions APAC is the major end user
- Analog IC Market sweet spot 0.13-0.18um
 - Market (\$) & units are growing
 - Not driven by number of transistors hence stable technology nodes
 - Typically long life cycle products
 - 300mm analog technology offerings starting to emerge TowerJazz to support next generations development and manufacturing with the TPSCo 300mm fab
 - Expertise in design, device, process a differentiator



Analog O-S-D Market – Main Observations

- Fast growing market
- Optoelectronics CIS to continue growing fast
- MEMS many promising growing markets (Consumer, automotive, industrial, communication ...)
 - We intend to expand our activity in this area as specialized foundry strategy
 - Penetration through partnership/purchase
- Discrete still growing nicely.
 - GaN is seen in the future



Strategy:

Main Focuses for Profitable Growth



- What do we want for 2016-2020?
 - TowerJazz continued growth
 - Utilization as a critical factor
 - Ensure our competitive advantage
 - Technology offering
 - Manufacturing capabilities
 - Retain our existing customers and increase customer base
 - Profitable business model with free cash flow creation
 - Continued branding: the leading analog specialty foundry



What questions to answer:

- Which of our growth engines should we retain (RF, TOPS, CIS, Power) and what is needed in order to retain them?
- What growth engines are we missing?
- Any new technical area that we need to enter to?
- Do we have the right facilities/ capacity to address growth needs?
- Any new geographic area that we need to enter?



What questions to answer:

– Which of our growth engines should we retain (RF, TOPS, CIS, Power) and what is needed in order to retain them?

YES. Continue to build RF/CIS/Power/TOPS

- Invest in roadmap to sustain the 8" and at the same time develop 300mm penetration
- Allow flexibility between fabs to ensure all are loaded
- Keep long life technologies in manufacturing at certain level to support cyclicality periods
- Automotive –take advantage of the growing market with long life through TPSCo capabilities



What questions to answer:

- What growth engines are we missing?
- Any new technical area that we need to enter to?

Sensors to fully meet IoT requirements

- Full MEMS sensors capability
- Magnetic sensors through technology partnership

Develop GaN offering – in progress



What questions to answer:

 Do we have the right facilities/ capacity to address growth needs?

YES.



What questions to answer:

– Any new geographic area that we need to enter?

Specific China Strategy

- Expand "std" business progressing well
- Partner to have local manufacturing capability (200mm and 300mm)





TowerJazz Investor and Analyst Day



Financial performance and Future Focus

Oren Shirazi | CFO

Financial Performance

	Q1′05	Q1'14	Q1′15	Q2′15	Q3′15	Q4'15
Revenue (\$M)	23	133	226	236	244	255
Non-GAAP Gross Margin (%)	(17)	34	36	37	38	41
EBITDA (\$M)	(14)	27	51	59	63	75
EBITDA Margin (%)	(61)	21	23	25	26	30
Non-GAAP Net profit (\$M)	(21)	19	50	54	58	70
Net Profit (\$M)	(55)	39	(73)	8	14	22
Net Profit excl. one-time items * (\$м)	(55)	(41)	2	8	14	22
Shareholders' Equity (\$M)	113	200	292	300	325	386
Cash On Hand (\$M)	35	183	134	143	155	206
Net Debt (\$M)	489	405	162	160	134	105
Net Debt/ Annual Ebitda (@৫*4)	infinite	3.75X	<0.8X	<0.7X	<0.6X	<0.4X

^{*} One time items included (i) for Q1'15, \$85 million non-cash bonds F conversion effect and \$10 million tax non-cash income; (ii) for Q1'14, \$151 million TPSCO acquisition gain, net and \$71 million Nishiwaki cessation relates costs, net



Fourth Quarter 2015 Financial Highlights

Q4 Revenues

\$255 million

RECORD REVENUES

Strong and continuous revenue growth

- Q4 record revenues of \$255 million (8% YoY growth)
 - Represents > \$1 billion annual run rate
- Q1 2016 mid range guidance of \$276 million (22% YoY growth)

Substantial Margins increase

- Q4 GAAP net profit of \$22 million, up from \$0.6M in Q4'14 and \$13.6M in Q3'15
- Record EBIDTA of \$75.5 million (35% YoY increase)
 - Represents annual EBITDA run rate of \$300 million
- GAAP gross margin in Q4'15 of 25% (up from 16% in Q4'14)

Strong Balance Sheet and Financial Ratios

- Reduced net debt to \$105 million (vs. \$318 million as of December 31, 2014)
- Increased cash and short-term deposits to \$206 million
- Reduced net debt/ EBITDA ratio from > 3.5X in Q1'14 to current < 0.4X
- Current ratio of 2.1X as of Dec' 31, 2015 Vs. 1.3X as of Dec' 2014



Full Year 2015 Financial Highlights

FY Revenues

\$961 million

RECORD REVENUES

Record Revenues

Record revenues for the full year of \$961 million (16% YoY growth)

Substantial Margins increase

- GAAP gross profit of \$205 million (more than 3X as compared to 2014)
- Record EBIDTA of \$249 million (62% YoY increase)
- GAAP net profits since the second quarter of 2015 with sustainable operational and financial business model for GAAP net profit
 - \$8M in Q2'15, \$13.6M Q3'15, \$22M Q4'15

Strong Balance Sheet and Financial Ratios

- Reduced net debt to \$105 million (vs. \$318 million as of December 31, 2014)
- Increased cash and short-term deposits to \$206 million
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- Current ratio of 2.1X as of Dec' 31, 2015 Vs. 1.3X as of Dec' 2014



Debt Summary

As of December 31, 2015 (as of December 31, 2014)

Bonds Debt Summary

Security Type	Linked to	Outstanding principal (\$M)	Key Terms
Bonds Series D	Israeli price index	6 (12)	Principal is due in December 2016; Straight bond, i.e not-convertible; Annual coupon of 8% payable once/year in December
Bonds Series F	\$	1 (197)	7.8% coupon payable twice / year; convertible at \$10 into ordinary shares; principal is due in 2 installments on Dec' 2015 and Dec' 2016
Jazz Bonds due 2015	\$	0 (45)	Annual coupon of 8% payable twice a year; Straight bond, i.e not-convertible; Principal was scheduled for June 2015; buy back done in January 2015
Jazz Bonds due 2018	\$	58	Annual coupon of 8% payable twice a year; convertible at \$10.07 into ordinary shares of Tower; Principal is due on December 2018

Banks Debt Summary

Security Type	Linked to	Outstanding principal (\$M)	Key Terms
IL Bank Loans	\$	83 (101)	Leumi & Po'alim Banks 50%:50%; \$6M payable 2016, \$56M 2017, \$21M 2018; Annual interest rate of Libor+ 3.9%
Jazz Wells Fargo Bank Credit Line	\$	19	\$19M actual drawdown under up to \$70M credit line; Annual interest rate of Libor + 1.5%; principal is due Dec'2018
Japanese Loan to TPSCo (TowerJazz Panasonic entity)	JPY	144 (74)	Tibor + 1.65% - 2.00% term loans from JA Mitsui, Sumitomo Mitsui Trust bank, Showa & Bank Of Tokyo; payable from 2016 through 2020

- Total Debt as of December 31, 2015 is \$311M vs. \$505M as of December 31, 2014:
 - Net debt is \$106M
 - •Reflecting < 0.4X Net Debt to EBITDA ratio



Healthy Cap Table

- √ 86M Shares outstanding
- ✓ 6M Convertible @ \$10/ share
- ✓ 7M ESOP
- ✓ 5M warrants @ \$7.3/ share
- ✓ 3M capital notes

√ 107M fully diluted

✓ No major shareholder with > 10%



TowerJazz - Balance Sheet (in millions of \$)

	December 31, 2015	September 30, 2015	December 31, 2014
CURRENT ASSETS			2011
Cash and cash equivalents	206	155	187
Trade accounts receivable	110	123	99
Other receivables	7	7	6
Inventories	106	104	88
Other current assets	18	24	14
Total current assets	447	413	394
Long-term investments	12	12	12
Property and equipment, net	460	431	419
Intangible assets, net	34	37	42
Goodwill	7	7	7
Other assets, net	7	7	10
TOTAL ASSETS	967	907	884
CURRENT LIABILITIES			
Current maturities of long-term debt	33	49	120
Trade accounts payable	92	112	99
Other current liabilities	86	91	81
Total Current Liabilities	211	252	300
Long-term debt	257	207	267
Employee related liabilities	14	16	17
Deferred tax liabilities	70	76	75
Other long-term liabilities	29	31	30
TOTAL LIABILITIES	581	582	689
Shareholders' equity	386	325	195
TOTAL LIABILITIES & EQUITY	967	907	884



TowerJazz – Q4'15 & FY'15 Sources & Uses (in millions of \$)

	Year	Three months	Three months	Three months
	ended	ended	ended	ended
	December 31,	December 31,	September 30,	December 31,
	2015	2015	2015	2014
Cash at beginning of the period	\$ 187,167	\$ 155,348	\$ 142,503	\$ 195,116
Cash from operations, excluding interest payments	207,584	54,779	54,689	41,218
Exercise of warrants and options, net	14,424	4,168	4,602	5,654
Long-term loan received by TPSCo	70,592	70,592		
Investments in property, equipment and other cap-ex	(165,655)	(58,137)	(39,579)	(26,569)
Debt repayment- principal	(69,689)	(18,006)	(3,000)	(15,980)
Debt repayment- interest	(12,371)	(1,599)	(3,867)	(12,708)
Nishiwaki cessation- employee termination related, net	(24,907)			436
TPSCo dividend to Panasonic	(1,570)	(1,570)		
Cash at end of the period	\$ 205,575	\$ 205,575	\$ 155,348	\$ 187,167



TowerJazz – Q4'15 & FY'15 Sources & Uses (in millions of \$)

		Year ended	
	2017	December 31,	
	2015	2014	2013
CASH FLOWS - OPERATING ACTIVITIES			
Net loss	\$ (29,127)	\$ (1,372)	\$ (107,660)
Adjustments to reconcile net loss for the period			
to net cash provided by operating activities:			
Income and expense items not involving cash flows:			
Depreciation and amortization	168,032	203,868	151,711
Financing expense associated with debentures series F	87,973	39,494	13,113
Effect of indexation, translation and fair value measurement on debt	16,078	(3,667)	4,091
Financing costs relating to Jazz notes exchange		9,817	
Other expense, net	190	140	904
Gain from acquisition		(166,404)	
Changes in assets and liabilities:			
Trade accounts receivable	(11,115)	(24,021)	(5,194)
Other receivables and other current assets	(14,979)	49,934	(3,647)
Inventories	(17,908)	(1,758)	(780)
Trade accounts payable	(26,162)	11,107	25
Deferred revenue and customers' advances	32,725	1,915	1,202
Other current liabilities	8,454	25,744	(38)
Deferred tax liability, net	(4,173)	(23,977)	(11,453
Other long-term liabilities	(14,775)	4,517	(6)
Nishiwaki's employees termination payments	(24,907)	(27,572)	
Net cash provided by operating activities	170,306	97,765	42,268
CASH FLOWS - INVESTING ACTIVITIES			
T 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	(165.350)	(50.200)	(77.044)
Investments in property and equipment, net (a)	(165,370)	(50,209)	(77,044)
Investments in other assets, intangible assets and others	(119)	(76)	(409)
Acquisition of subsidiary consolidated for the first time (b)	(20,000)	57,582	
Decrease (increase) in Interest bearing deposits	(30,000)	10,000	(55.452)
Net cash provided by (used in) investing activities	(195,489)	17,297	(77,453)
CASH FLOWS - FINANCING ACTIVITIES			
Proceeds from exercise of warrants and options	14,424	10,399	105
Proceeds from issuance of debentures, net		9,214	100
Proceeds on account of shareholders' equity, net),21 4	38,851
Proceeds from long-term loans	70,592	85,884	30,031
Short-term loan repayment to Panasonic	70,572	(85,884)	
Bank debt repayment	(18,200)	(41,181)	
Debentures repayment	(51,489)	(10,230)	(6,540)
TPSCo dividend to Panasonic	(1,570)	(10,200)	(0,210)
Net cash provided by (used in) financing activities	13,757	(31,798)	32,416
Effect of foreign exchange rate change	(166)	(8,968)	(7,758)
INCREASE (DECREASE) IN CASH AND CASH EQUIVALENTS	(11,592)	74,296	(10,527)
CASH AND CASH EQUIVALENTS - BEGINNING OF PERIOD	187,167	112,871	123,398
CACH AND CACH FOUNTALENTS. END OF BEDIOD	b 155.555	¢ 107.177	\$ 112.871
CASH AND CASH EQUIVALENTS - END OF PERIOD	\$ 175,575	\$ 187,167	\$ 112,871



Q4'15 Financial Statements (Vs. Q4'14), in thousands of \$

	Three month Decembe		Three mont		Three month Decembe		
-	2015	2014	2015	2014	2015	2014	
	non-GA	AP	Adjustn	nents	GAAP		
REVENUES \$	254,602 \$	235,289 \$	\$	\$	254,602 \$	235,289	
COST OF REVENUES	150,322	151,105	39,750	46,092	190,072	197,197	
GROSS PROFIT	104,280	84,184	(39,750)	(46,092)	64,530	38,092	
OPERATING COSTS AND EXPENSES							
Research and development	14,224	13,676	1,480	702	15,704	14,378	
Marketing, general and administrative	14,518	14,623	960	902	15,478	15,525	
Nishiwaki Fab restructuring costs and impairment			(991)	(20,228)	(991)	(20,228)	
<u>-</u>	28,742	28,299	1,449	(18,624)	30,191	9,675	
OPERATING PROFIT	75,538	55,885	(41,199)	(27,468)	34,339	28,417	
INTEREST EXPENSE, NET	(2,366)	(7,817)			(2,366)	(7,817)	
OTHER NON CASH FINANCING EXPENSE, NET			(12,751)	(17,156)	(12,751)	(17,156)	
OTHER INCOME, NET	70	15	<u></u>		70	15	
PROFIT BEFORE INCOME TAX	73,242	48,083	(53,950)	(44,624)	19,292	3,459	
INCOME TAX BENEFIT (EXPENSE)	(1,107)	1,410	5,886	(670)	4,779	740	
PROFIT BEFORE NON CONTROLLING INTEREST	72,135	49,493	(48,064)	(45,294)	24,071	4,199	
NON CONTROLLING INTEREST	(1,992)	(3,575)			(1,992)	(3,575)	
NET PROFIT \$	70,143 \$	45,918 \$	(48,064) \$	(45,294) \$	22,079 \$	624	
GROSS MARGINS	41.0%	35.8%			25.3%	16.2%	
OPERATING MARGINS	29.7%	23.8%		=	13.5%	12.1%	
NET MARGINS	27.6%	19.5%		<u>=</u>	8.7%	0.3%	



Q4'15 Financial Statements (Vs. Q3'15), in thousands of \$

<u>1</u> - -	December 31, 2015	nths ended September 30, 2015 GAAP	December 31, 2015	nths ended September 30, 2015 tments	Three more December 31, 2015	September 30, 2015
REVENUES \$	254,602	\$ 244,181	· 9	\$ S	\$ 254,602 \$	244,181
COST OF REVENUES	150,322	150,575	39,750	38,223	190,072	188,798
GROSS PROFIT	104,280	93,606	(39,750)	(38,223)	64,530	55,383
OPERATING COSTS AND EXPENSES	00000000000000000000000000000000000000		10000000000000000000000000000000000000	100000000000000000000000000000000000000	80000000000000000000000000000000000000	100000000000000000000000000000000000000
Research and development	14,224	15,777	1,480	203	15,704	15,980
Marketing, general and administrative	14,518	14,776	960	572	15,478	15,348
Nishiwaki Fab restructuring costs and impairment			(991)		(991)	
=	28,742	30,553	1,449	775	30,191	31,328
OPERATING PROFIT	75,538	63,053	(41,199)	(38,998)	34,339	24,055
INTEREST EXPENSE, NET	(2,366)	(3,567)			(2,366)	(3,567)
OTHER NON CASH FINANCING EXPENSE, NET			(12,751)	(5,312)	(12,751)	(5,312)
OTHER INCOME (EXPENSE), NET	70	(247)			70	(247)
PROFIT BEFORE INCOME TAX	73,242	59,239	(53,950)	(44,310)	19,292	14,929
INCOME TAX BENEFIT (EXPENSE)	(1,107)	(1,195)	5,886	268	4,779	(927)
PROFIT BEFORE NON CONTROLLING INTEREST	72,135	58,044	(48,064)	(44,042)	24,071	14,002
NON CONTROLLING INTEREST	(1,992)	(451)			(1,992)	(451)
NET PROFIT \$	70,143	\$ 57,593	(48,064)	(44,042)	\$ 22,079	13,551
GROSS MARGINS	41.0%	38.3%			25.3%	22.7%
OPERATING MARGINS	29.7%	25.8%			13.5%	9.9%
NET MARGINS	27.6%	23.6%			8.7%	5.5%



FY'15 Financial Statements (Vs. FY'14), in thousands of \$

	Year ended		Year ended		Year ended	
	December 31,		December 31,		December 31,	
	2015	2014	2015	2014	2015	2014
	non-GAAP		Adjustments		GAAP	
REVENUES \$	960,561 \$	828,008 \$	s \$	\$	960,561 \$	828,008
COST OF REVENUES	594,610	569,102	160,586	195,118	755,196	764,220
GROSS PROFIT	365,951	258,906	(160,586)	(195,118)	205,365	63,788
OPERATING COSTS AND EXPENSES						
Research and development	58,797	49,976	2,872	1,865	61,669	51,841
Marketing, general and administrative	58,608	55,057	4,185	3,726	62,793	58,783
Nishiwaki Fab restructuring costs and impairment			(991)	55,500	(991)	55,500
Merger related costs				1,229		1,229
	117,405	105,033	6,066	62,320	123,471	167,353
OPERATING PROFIT (LOSS)	248,546	153,873	(166,652)	(257,438)	81,894	(103,565)
INTEREST EXPENSE, NET	(13,179)	(33,409)			(13,179)	(33,409)
OTHER NON CASH FINANCING EXPENSE, NET			(109,930)	(55,404)	(109,930)	(55,404)
GAIN FROM ACQUISITION, NET				166,404		166,404
OTHER EXPENSE, NET	(190)	(140)			(190)	(140)
PROFIT (LOSS) BEFORE INCOME TAX	235,177	120,324	(276,582)	(146,438)	(41,405)	(26,114)
INCOME TAX BENEFIT (EXPENSE)	(3,469)	1,563	15,747	23,179	12,278	24,742
PROFIT (LOSS) BEFORE NON CONTROLLING INTEREST	231,708	121,887	(260,835)	(123,259)	(29,127)	(1,372)
NON CONTROLLING INTEREST	(520)	5,635			(520)	5,635
NET PROFIT (LOSS) \$	231,188 \$	127,522 \$	(260,835) \$	(123,259) \$	(29,647) \$	4,263



Corporate Financial Targets 2016

- Revenue:
 - Target: growth throughout the year
- Continue to improve the margins across the board
 - 1-2 points negative first year impact of TJT (San Antonio fab)
 on margin percent but positive on all cash indices
 - Target:
 - GAAP operating margin from 8% for FY 2015 to double digit throughout 2016 with H2>H1

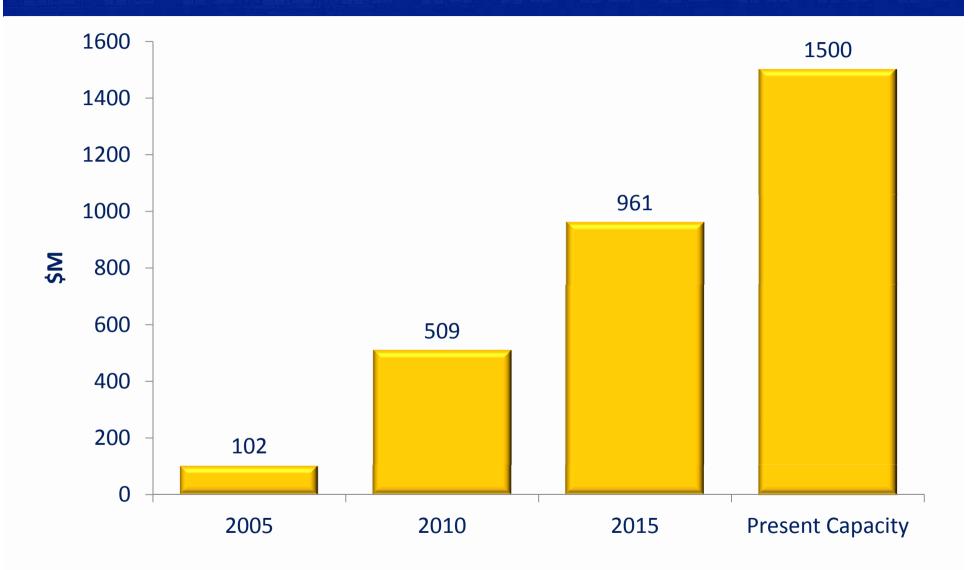


Focus: Net profit 2016/2017

- Maintain and grow positive net profit
 - Achieved: Q2'15 \$8M → Q3'15 \$14M → Q4'15 \$22M
 - 2016 target: growth against Q4'15 annualized baseline
 - MH Fab2 capacity ramp at high utilization
 - NPB Fab3 realization of annualized capacity increase
 - TPSCo 3rd party revenues ramp to >\$25M/ quarter by EOY
 - 2017 target: additional growth
 - Fab2 realization of annualized capacity increase
 - Fab3 with higher margin mix
 - TPSCo 3rd party revenues increase to >\$50M/ quarter by EOY
 - TJT (San Antonio fab) revenue growth >25% 2017/16



Annual Revenues





Financial Performance and Model

		Q4'15
Revenue (\$M)		255
Non-GAAP Gross Margin (%)	 Q4'15 reflects \$1.02B of annualized revenues which resulted in: \$300M EBITDA annual run rate \$88M net profit annual run rate At the maximal potential of \$1.5B of revenues, by model: Over \$150M added EBITDA Over \$100M added net profit 	41
EBITDA (\$M)		75
EBITDA Margin (%)		30
Non-GAAP Net profit (\$M)		70
Net Profit (\$M)		22
Net Profit excl. one-time items * (\$м)		22
Shareholders' Equity (\$M)		386
Cash On Hand (\$M)		206
Net Debt (\$M)		105
Net Debt/ Annual Ebitda (@এ•4)		<0.4X

^{*} One time items included (i) for Q1'15, \$85 million non-cash bonds F conversion effect and \$10 million tax non-cash income; (ii) for Q1'14, \$151 million TPSCO acquisition gain, net and \$71 million Nishiwaki cessation relates costs, net





TowerJazz Investor and Analyst Day



RF and Power

Markets and Growth Drivers

RF HPA Markets: \$300M Revenue, 50% '14 to '15 Growth



Wireless
RF SOI and SiGe

High Growth driven by Smartphones and IoT



Infrastructure HP SiGe

High Growth driven by video, data internet traffic



Other SiGe

Emerging Applications driven by radar and other high-frequency applications, and Traditional Analog Markets in HDD and analog components



RF HPA Markets: \$300M Revenue, 50% '14 to '15 Growth



Wireless RF SOI and SiGe

High Growth driven by Smartphones and IoT



Infrastructure HP SiGe High Growth driven by video, data internet traffic

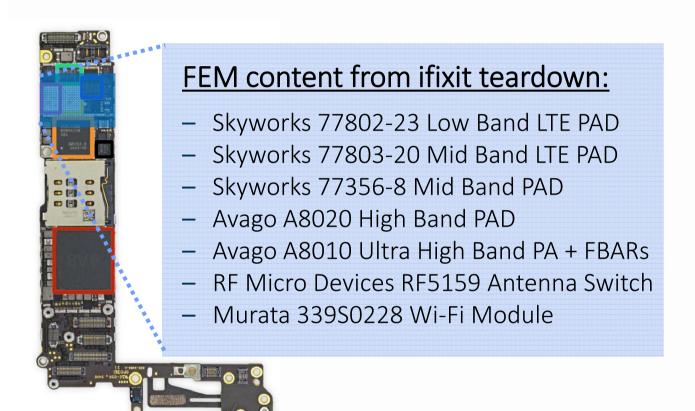


Other SiGe

Emerging Applications driven by radar and other high-frequency applications, and Traditional Analog Markets in HDD and analog components



Wireless FEM content in iPhone 6

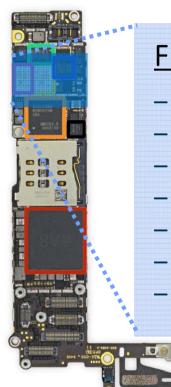




RF Front-End-Module Content Growing

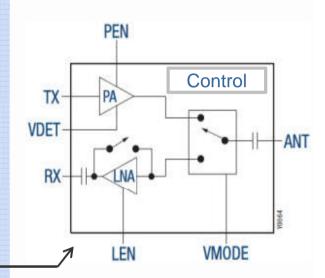


Wireless FEM content in iPhone 6



FEM content from ifixit teardown:

- Skyworks 77802-23 Low Band LTE PAD
- Skyworks 77803-20 Mid Band LTE PAD
- Skyworks 77356-8 Mid Band PAD
- Avago A8020 High Band PAD
- Avago A8010 Ultra High Band PA + FBARs
- RF Micro Devices RF5159 Antenna Switch
- Murata 339S0228 Wi-Fi Module _____

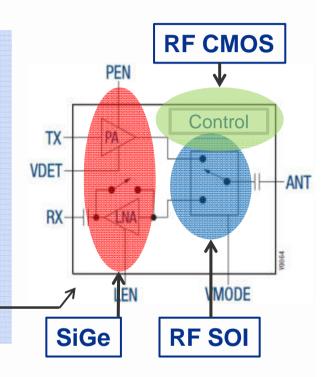


Switch, Low-Noise Amp (LNA), Power Amp (PA), Control are inside a FEM



Wireless FEM content in iPhone 6





TowerJazz RF Technologies Used to Build these Components RF SOI (Switch), SiGe (LNA/PA), RF CMOS (Control)

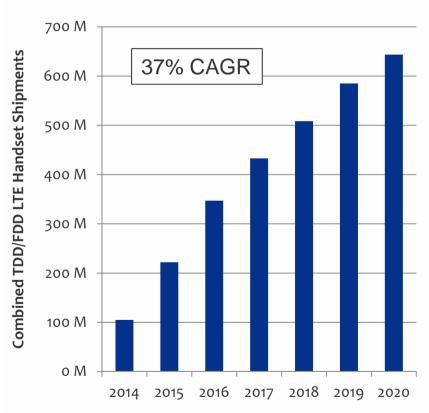


Mobile Market

Overall Growth Continues

3,500 M 5% CAGR LTE-FDD 3,000 M ■ TD-LTE 2,500 M TD-SCDMA **Mobile Market** ■ WCDMA/HSP 2,000 M Α CDMA/EVDO only 1,500 M ■ GSM/EDGE only 1,000 M 500 M о М 2015 2016 2017 2018 2019 2020

More Complex 4G-LTE Growth is Stronger (5G could start in 2020)

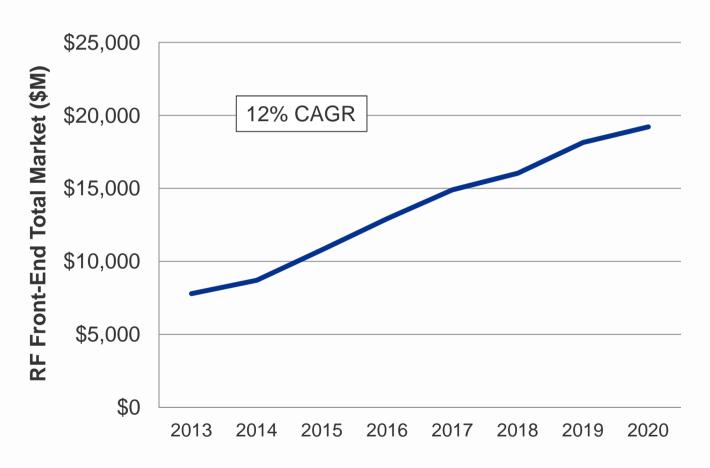


Source: Mobile Experts Source: Mobile Experts



RF Front-End-Module Market

Leading to Strong Front-End-Module Market Growth

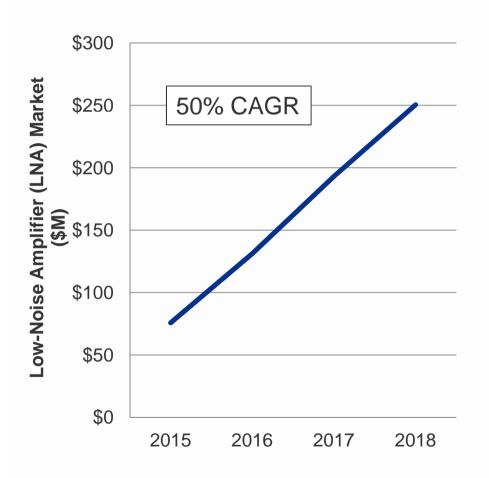


Source: Mobile Experts



Opportunity to Exceed Market Growth

Low Noise Amplifier



Reasons for Strong Growth

- Diversity Antenna (doubling the need)
- Main LNA coming off Transceiver
- GPS/WiFi LNA attach rate

Primary Technology Used for LNA

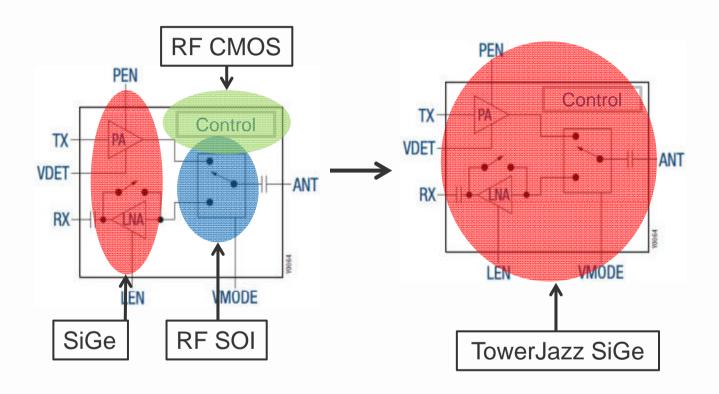
SiGe or RF SOI increasing share PHEMT/CMOS decreasing share

Source: Mobile Experts



Opportunity to Exceed Market Growth

SiGe Power Amplifier and FEM Integration

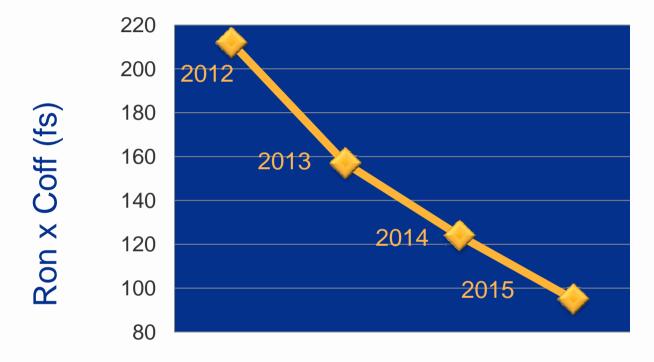


Power Amplifier Market is Large (>\$3B) and Today largely GaAs SiGe PA promises acceptable performance, lower cost, higher integration



Opportunity to Exceed Market Growth

Technology Leadership in RF SOI



Best in class process technology provides Power and

Data Rate advantage for our customers and their customers



RF HPA Markets: \$300M Revenue, 50% '14 to '15 Growth



Wireless
RF SOI and SiGe

High Growth driven by Smartphones and IoT



Infrastructure HP SiGe

High Growth driven by video, data internet traffic



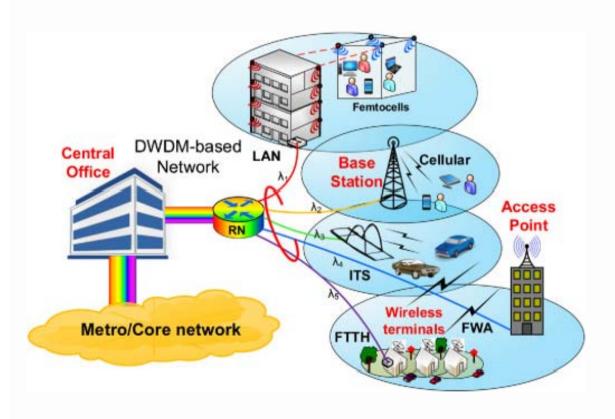
Other SiGe

Emerging Applications driven by radar and other high-frequency applications, and Traditional Analog Markets in HDD and analog components



Optical Fiber Data Transport

Data Networks



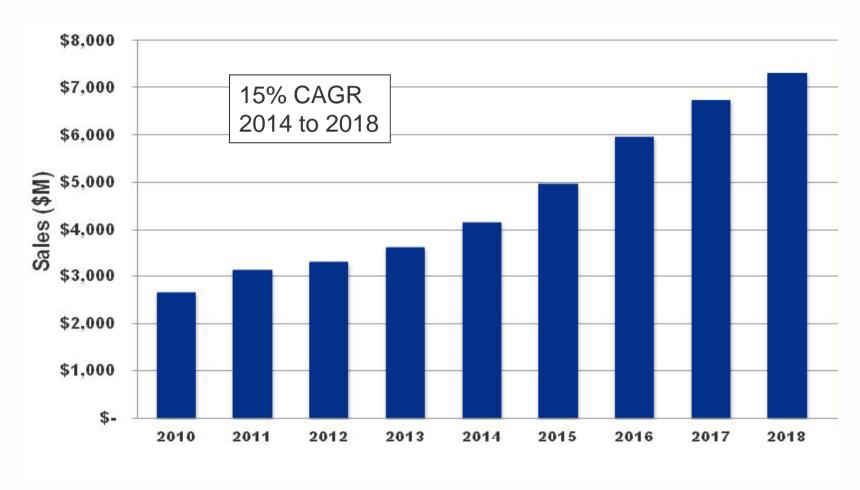
Data Centers







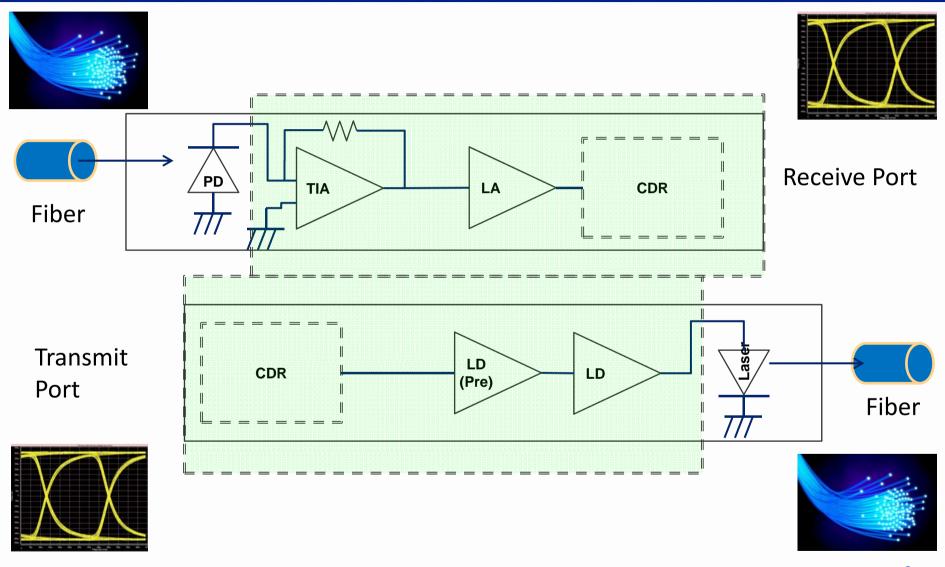
Total Market for Optical Transceivers







Front-End Components We Enable





TowerJazz Strategy to Maintain Strong Market Position

1. High Performance SiGe Technology Leadership

- Best in class overall SiGe figures of merit
- Offer unique, patented feature to boost performance of TIAs

2. Tier 1 customers partnering on Roadmap

Estimate to own >50% of the serviceable market today

3. Exploring Si Photonics to expand serviceable market

Potential for future growth in addition to SiGe



RF HPA Markets: \$300M Revenue, 50% '14 to '15 Growth



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RF SOI and SiGe

High Growth driven by Smartphones and IoT



Infrastructure HP SiGe

High Growth driven by video, data internet traffic



Other SiGe

Emerging Applications driven by radar and other high-frequency applications, and Traditional Analog Markets in HDD and analog components



Example: Automotive Radar for Collision Avoidance

Technology Description

- 24GHz and 77GHz Standards
- Good match with TowerJazz SiGe
- Good design win pipeline

Market Potential

- 74M Cars sold per year (2016)
- As many as 7 sensors per car
- 20% penetration would result in 100M Units/Year TAM



Example: Hard Disk Drive PreAmp

Technology Description

- PreAmp to read/write disk is built in c-SiGe
- TowerJazz has recently developed a competitive c-SiGe Technology



Market Potential

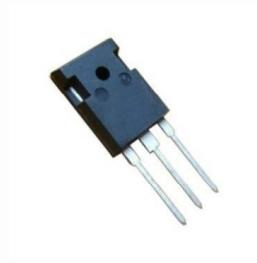
- 550Mu per year (2016)
- Cloud storage increase balancing PC decline in HDD to maintain market
- Little market share today for TowerJazz results in a large opportunity



Power Markets: \$265M Revenue, 20% '14 to '15 Growth



Power ICs 0.18um BCD



Power Discrete
TOPS Business Model



Sensor and Controller Clock Overview Monitor AC CPU Adaptor Power Battery Logic Charge CPU LCD Power Power and **Power Products** Backlight LCD Display FSB FlatLink Power Handle Driver SODIMMO Memory UMA RGB High Voltage OR SODIMM1 Out Graphics: DAC **Battery Pack GMCH** Power High Current OR Video NTSC/PAL Encoder L-lon Out Discrete **Both** Protection Power Analog Video In Video I2C SMBus Decoder Hub In-Pack HDMI Gas DisplayPort (1990) Power Gauge VGA Out (XXXX) Video Switch Translator DVI Out 1394b 1394 Docking PCIe Controller Switch PCI/PCIE PCle GbE LAN LAN Bridge USB₁ MAC/PHY Switch USB/RF LAN Port Dongle Switch USB Audio ICH Power CODEC Switch Power Cardbus <u>ICs</u> PC Card Phone -Controller Switch SATA HDD Headphones or Dock Power Express Switch Integrate Power and control eSATA MiniCard1 Power Memory Switch Card Load MiniCard2 Fingerprint Scan Switch **Discrete** 1/0 Expander ODD USB to PATA Super IO (PATA) **Power Transistors**

Serial

I/O

(ww)

Keyboard

(MSP430)

Touchpad and

Buttons

Plug

AC Line

LEGEND

Process

Interfa-

RF/IF

▶ Amplifi Logic

Power

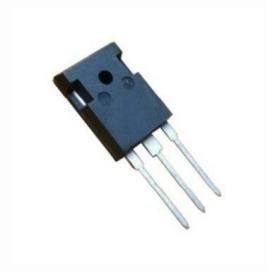
ADC/D/

Clocks
Other

Power Markets: \$265M Revenue, 20% '14 to '15 Growth



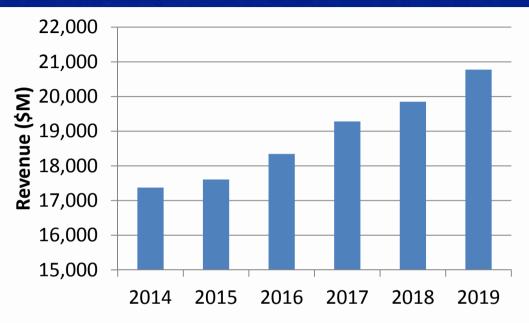
Power ICs 0.18um BCD



Power Discrete
TOPS Business Model



Power IC Market



Source: IC Insights (partitioning of ASSP into Power IC and other markets done by TowerJazz)

TowerJazz Position and Strategy for Growth

- 2014 to 2015 TowerJazz growth significantly outpaced market growth
- Gaining share through:
 - Joint development with 1st tier IDM
 - Differentiated technology enabling Fabless or Fab light



Low Voltage
1.8V / 5V-60V
PMIC, DC/DC, Audio,
Display/Motor Drivers, POE

Medium Voltage 80V–200V Automotive, Industrial, Medical High Voltage 200V-700V AC/DC, LED Lighting, IGBT and MOSFET Drivers



Low Voltage
1.8V / 5V-60V
PMIC, DC/DC, Audio,
Display/Motor Drivers, POE

Medium Voltage 80V–200V Automotive, Industrial, Medical High Voltage
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Low Voltage
1.8V / 5V-60V
PMIC, DC/DC, Audio,
Display/Motor Drivers, POE

Medium Voltage 80V–200V Automotive, Industrial, Medical High Voltage
200V-700V

AC/DC, LED Lighting, IGBT and MOSFET Drivers







TS18PM + 1.8V Digital

TS35PM Vgs=5V Vds=5V-120V, eNVM

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Information herein shall not be furnished to third parties or made public.

The Global Specialty Foundry Le

Low Voltage
1.8V / 5V-60V
PMIC, DC/DC, Audio,
Display/Motor Drivers, POE

Medium Voltage 80V–200V Automotive, Industrial, Medical High Voltage 200V–700V AC/DC, LED Lighting, IGBT and MOSFET Drivers







TS18UHV + up to 700V LDMOS

TS18PM + 1.8V Digital

TS35PM Vgs=5V Vds=5V-120V, eNVM

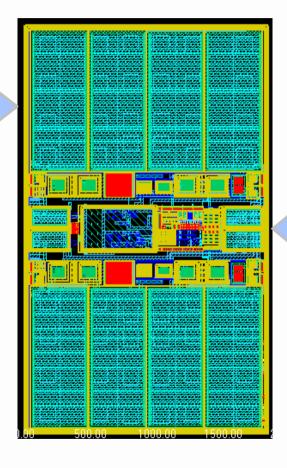


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Information herein shall not be furnished to third parties or made public.

Unique Features: Isolation Advantage

Power transistors manage dozens of watts at current levels of several amps and inject high currents to substrate

Good isolation prevents noise from disrupting the control circuits



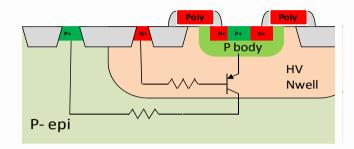
The control circuits operated at micro amps are exposed to substrate noise



Unique Features: Isolation Advantage

Base Isolation: (LED, DC-DC)

- Guard rings provides the lateral isolation
- Typical for less than 1.5A applications



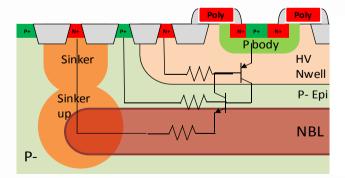
Shallow Epi: (Class D, Motors)

- Suppressed substrate current
- Typical for 2A to 5A applications

Pe No Pe No

Deep Epi: (AMOLED, POLs)

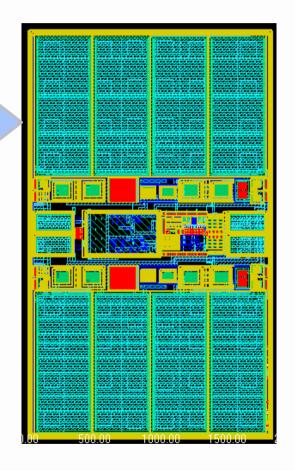
- Suitable for negative voltage operation
- Ideal for 5A to 20A applications





Unique Features: Die Size or Rdson Advantage

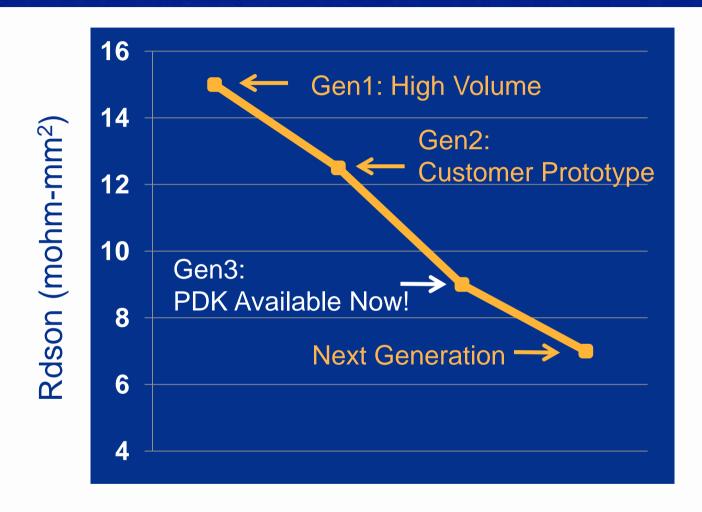
Area of Power transistors directly proportional to "Rdson" of the process technology



Low Rdson
Results in smaller
die, less heat,
lower cost



Unique Features: Die Size or Rdson Advantage



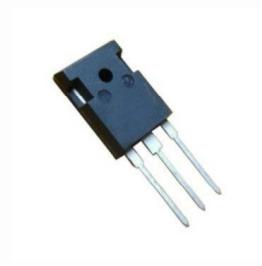
Best Foundry Rdson Offering with Aggressive Roadmap



Power Markets: \$265M Revenue, 20% '14 to '15 Growth



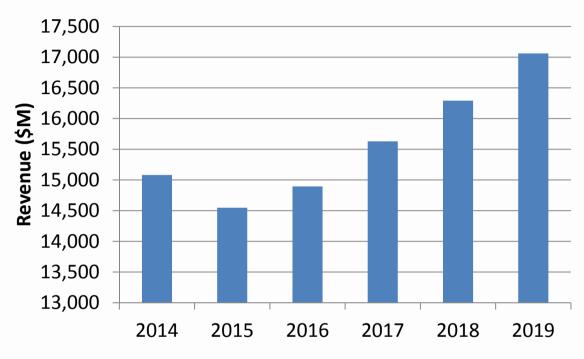
Power ICs 0.18um BCD



Power Discrete
TOPS Business Model



Power Discrete Market



Source: IC Insights

TowerJazz Position and Strategy for Growth

- 2014 to 2015 TowerJazz grew revenue despite market decline
- Gaining share through TOPs model due in part to industry and factory consolidation



Summary

RF and HPA

- Wireless: Strong growth driven by smartphone and IoT FEM
- Infrastructure: growth from fiber-optic data transport
- Other: emerging markets such as automotive radar and growth opportunities through share gains in other analog markets

Power

- IC: strong technology (IDM-like) to gain share from IDMs through fabless and fab-light customers
- Discrete: Tier 1 customer base through TOPs Business model gaining share through fab closures, consolidation and next generation enablement





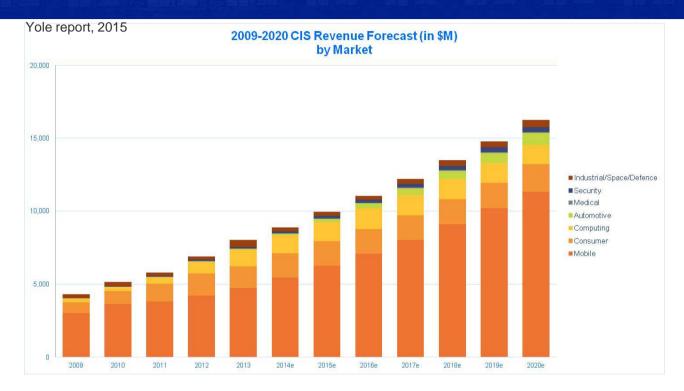
TowerJazz Investor and Analyst Day



CIS Specialty Offering, Markets and Growth Drivers

Dr. Avi Strum | SVP and GM, CMOS Image Sensor BU

Overall CMOS Image Sensors Market



- Revenues are dominated by mobile, consumer and computing which represent ~90% of all CIS revenues in 2014.
 - Mobile represents 60-70%.
- From 2014 to 2020, global revenue growth will remain at ~10.6% CAGR.
- Automotive, Medical and Security growth is much higher than the average (2 to 3x higher)



TowerJazz CIS Key Focus Markets

Technology, Flexibility, Experience and Commitment allows our customers to bring to the market the best in class products

Professional Photography

Highest requirements for image quality Large sensors, very high resolution, demanding frame rate Very low defect count Very high sensitivity, dynamic range & low noise



Smallest endoscopy solution





Industrial & High Speed

High speed and high accuracy Global shutter technology "Intelligent" pixels 2D and line sensors







Automotive & Security

Medical X-Ray

Supplying all Tier-1 vendors

High sensitivity and high dynamic range High NIR sensitivity Linear HDR for color imagers

Market Leader for dental x-ray CMOS





3D Gesture Control

Design wins with market leaders High volume and yet good margin market High NIR sensitivity ToF and structured light solutions





High end Photography

Market

- High end DSLR and ILC/MLC
- Cinematography and Broadcast high end video
- ~15Mu annually
 - Wafer value of ~\$1B (SAM)



- Nikon (~40%), Canon (~40%), Sony (~10%)
 - Nikon buys sensors from Sony
 - Canon produce their own sensors (older technology)

Opportunity

- TPSCo 300mm 65nm state of the art technology and Panasonic reputation
- Japanese fab that can be an alternative to Sony or internal manufacturing







Industrial high speed global shutter cameras

Market

- Still CCD dominated, suppliers are Sony, Dalsa, Panasonic
- Fast move to CMOS
 - Sony announced EOL of CCD
- Estimated sensor market size \$300M (\$100M in wafer value)



Opportunity

- TowerJazz serves most of the providers (e2v, On Semi, CMOSIS,...) that competes against Sony
- TPSCo 110nm technology supports the smallest pixels in the industry (2.8um) and will serve as the next generation platform for our customers (for ~10 years)









Dental and Medical X-Ray sensors market

Market

- Intra oral digital sensors
- Extra oral digital sensors (panoramic and CT)
- Medical Large panels, currently served by TFT technology
- Current market ~\$30-40M in wafers value

Current

- TowerJazz already has >50% market share in the intra oral market
- Fast growth in the extra oral and medical markets

Opportunity

- Replacement of most of the TFT panels with CMOS.
- Can bring the market wafer value to >\$200M









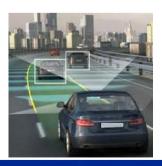


Automotive

- Market: The fastest growing camera market
 - Forward and backwards looking cameras
 - Side cameras replacing mirrors
 - External ADAS cameras for lane departure and colission warning
 - Internal cameras for head positioning warning
 - 3D gesture control camera
- TowerJazz and TPSCo already sell to the automotive market
 - We can leverage Panasonic reputation and the Fab location
 - Technology for very high dynamic range and high sensitivity





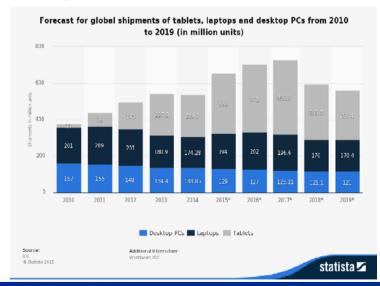






3D gesture recognition and gesture control

- Market: the hottest market in the PC and gaming area
 - Intel's RealSense™ technology for gesture control
 - AR (Augmented Reality) and VR (Virtual Reality) for gaming and simulations
 - 3D rendering for 3D printing
 - 15-20% of total market = ~90-120Mu
 - Roughly \$100-130M market in wafer revenue







Summary

- TowerJazz focus on the fastest growing CIS market applications
 - Automotive/ Security
 - Medical
 - 3D
 - Industrial
- Focused markets have much longer life for devices and for process node
- Higher and more stable ASPs and margins compared with the cellular market





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Worldwide Operational Overview

TJ Operations in Numbers



3804

Employees Worldwide

Profession	Total
Engineers	720
Technicians	591
Operators	2155
Support	86
Managers	252
Total	3804

Tech: 59% Males & 41% Females 100% 50% 68% 32%

410

NPB

MH

New employees were hired during 2015.



7 Fabs
With 2.3M
wafer
Capacity

6170 Active Products





Israel - 18

Europe-42 Korea- 24

Japan- 20

China- 40

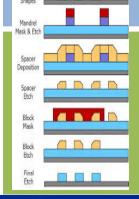
Taiwan-9

USA - 149

302 Worldwide Customers



1160 Active Process Flows



1252 New products In 2015



334 New Operation With full redundancy-

Rarely Stops

3178 Tools

6": 350

8": 2536

12": 292

added

during 2015

TJ Operations Main Targets & Challenges

Capacity & Utilization

Target High Asset utilization of 85%

Build new Capacity (Packaged deals with the OEM and 3rd party used tools), Duplicate major process flows between Fabs to increase operational flexibility.

OSD & Lead Time

Strive for Best in benchmark OSD and Lead time

OSD >98% and Lead-time <2 DPL at 0.18u Technology. Priority Lots to expedite New developments and Introduction of new products.

Capacity & Utilization

Target High Asset utilization of 85%

Build new Capacity (Packaged deals with the OEM and 3rd party used tools), Duplicate major process flows between Fabs to increase operational flexibility.

Quality: Plant Yield Die Yield & RMA

CPk> 1.67, **Plant Yield >97.5%**, **RMA <0.2%**, typical Die Yield >95%.

Support Automotive customers. ISO Certified for : Quality- ISO 9001; Environmental-14001; IP Security- BS/ISO 27001; Safety- OHSAS 18001; Automotive – ISO 16949

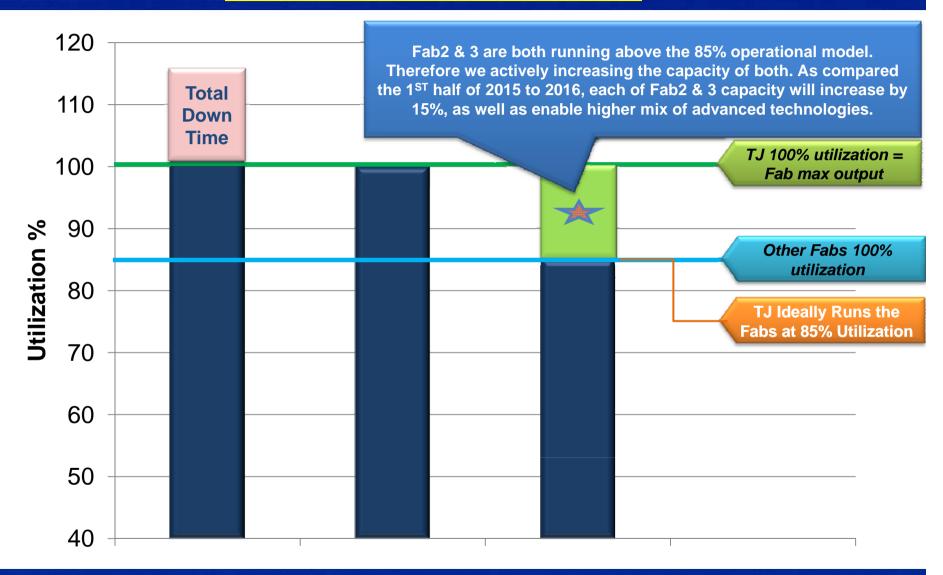
New Technologies Ramp to Mass Production

Align the technological Roadmap with major customers

Transfer new technologies from the R&D to the Fabs and Ramp into mass production with the Quality mentioned above.



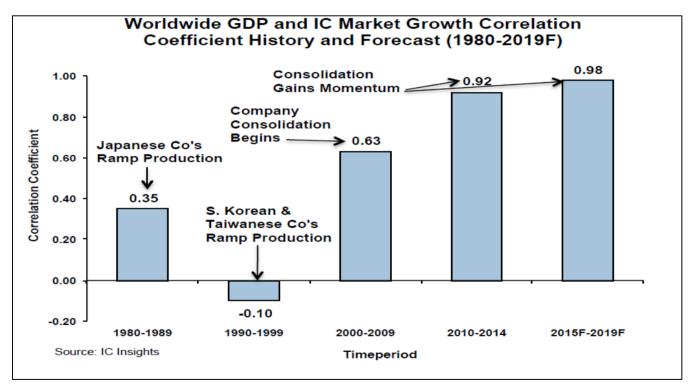
TJ Utilizing the Equipment X% above others TJ 85% utilization = Others 100%.





IC industry shifts to a top-down model driven by consumer spending.

• While worldwide electronic systems production represents only 2% of the worldwide GDP, the interdependence between them is on the rise as the IC industry shifts from a bottom-up business model driven by capacity and capital spending, to a top-down model driven by consumer spending.

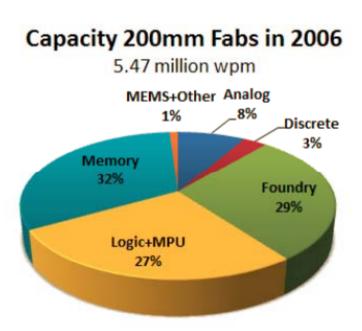


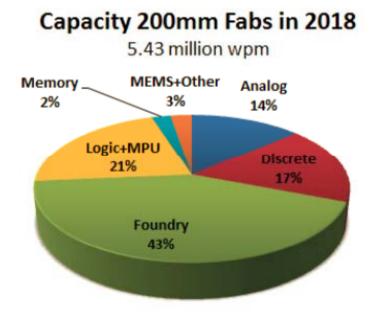
 McClean came to this conclusion by comparing the correlation coefficient between the Worldwide GDP and IC market since the '80s and forecasted out to 2018 (Figure 1).



Change of Landscape- 200mm Capacity by Product type

- 19M WPY for Foundry in 2006 growing to 28M WPY in 2018.
- TJ 200mm (excluding F1 and F7) grow from 0.42M WPY in 2006 (2.2% of foundry capacity) to ~2M WPY (7.2%) in 2018

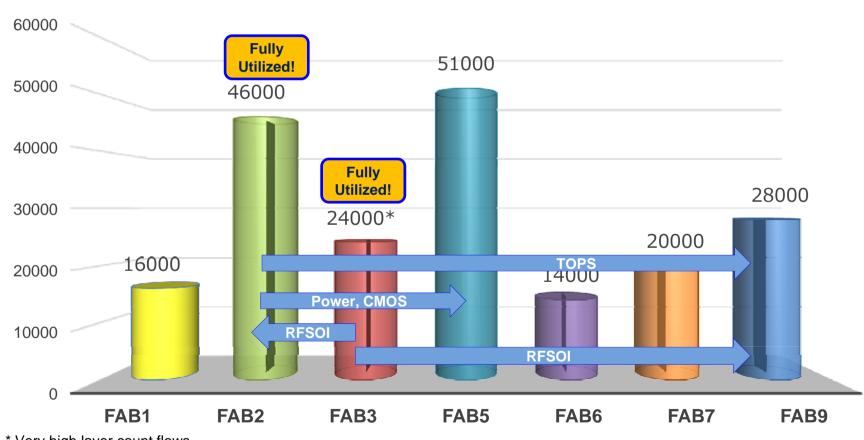


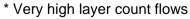




TJ Capacity – 2.3M wafers / Year (8" equivalent)

RFSOI offload from Fab3 to Fab2 and Fab9 (SA) and TOPS from Fab2 to Fab9







TJ Operations Main Targets & Challenges

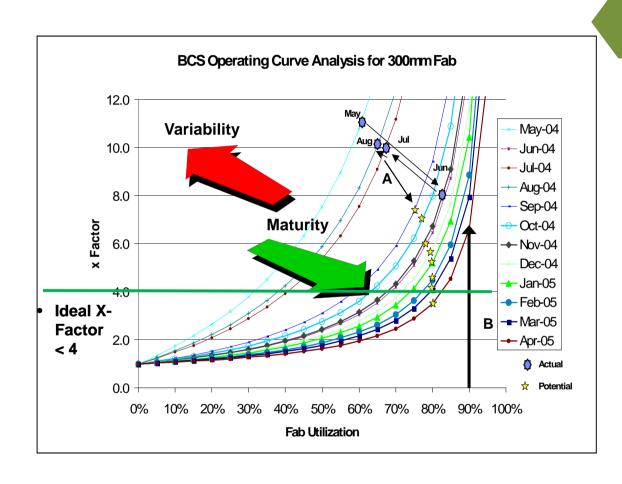
OSD & Lead Time

Strive for Best in benchmark OSD and Lead time

OSD >98% and Lead-time <2 DPL at 0.18u Technology. Priority Lots to expedite New developments and Introduction of new products.



Reduce variability through Lean and Six Sigma principles and Increase Loading with minimal Impact on CT.



Variability Reduction

Lower Variability will allow higher assets utilization with reasonable CT.

- Controlled Priority Lots /Hot Lots
- Higher Redundancy
- Operators and technicians Skills
- WIP balance
- Product/Process Mix
- Reliable equipment (random Failures and PM events)
- Batch for transport between operation



TJ Operations Main Targets & Challenges

Cost Savings

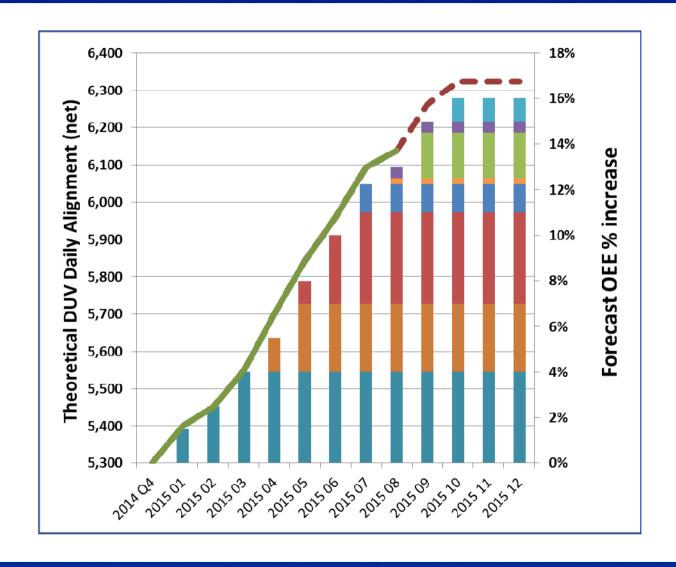
Must produce parts at the absolute lowest possible cost

OEE improvement projects on BN, Qualify alternative materials and Parts, Reduce material usage, Lower price on same materials.



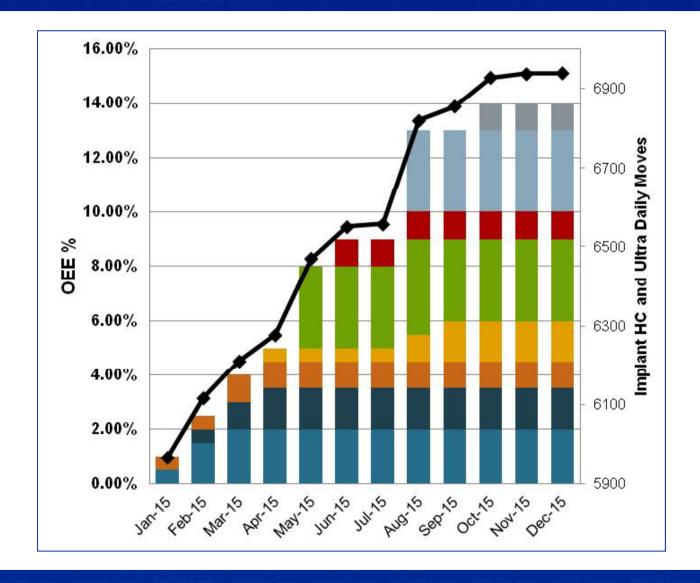
11

Photo Cell OEE improvement - Gained 75% of a Photo Cell = Capacity increase without capital spending





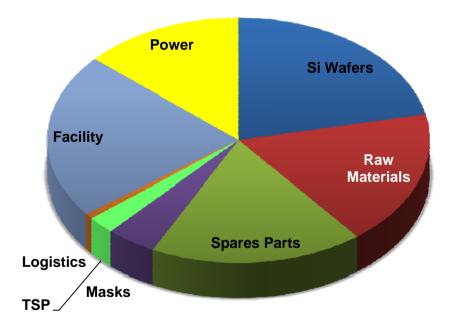
Implant HC OEE improvement - Gained 90% of a n Implanter= Capacity increase without capital spending





Total Expenses in 2015 by Category

- Yearly cost reductions achieved by:
 - Reduced usage optimization
 - Joint supplier efficiency programs
 - Post M&A price negotiations





Quality: Plant Yield Die Yield & RMA

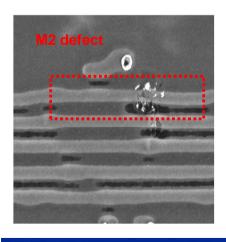
CPk> 1.67, **Plant Yield >97.5%**, **RMA <0.2%**, **typical Die Yield >95%**.

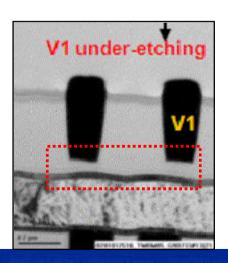
Support Automotive customers. ISO Certified for : Quality- ISO 9001 ; Environmental-14001; IP Security- BS/ISO 27001;Safety- OHSAS 18001; Automotive – ISO 16949

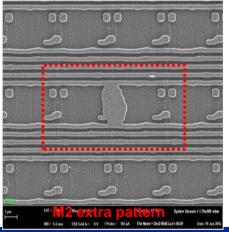


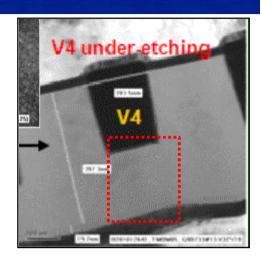
Imperfections in Fab Processes: Face it. Fix it.

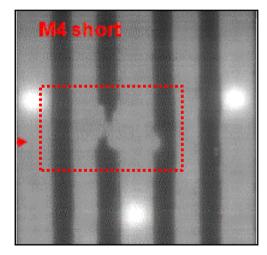
- Mask making: Dust, focusing
- Growing oxide: Warping in furnace, uneven reactions
- Resist: Over exposure, not hardened enough, Lifting
- Etching: Over etch of resist and/or oxide
- Lateral diffusion: Affects transistor channel lengths
- Multiple layers: Mask alignment
- Defect/Residues: from the process chamber walls.







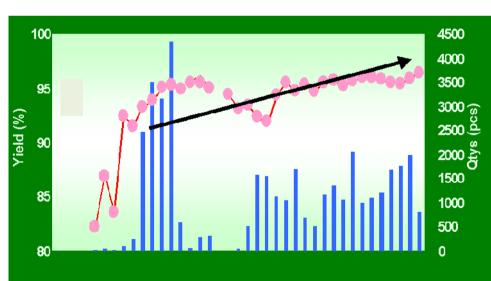


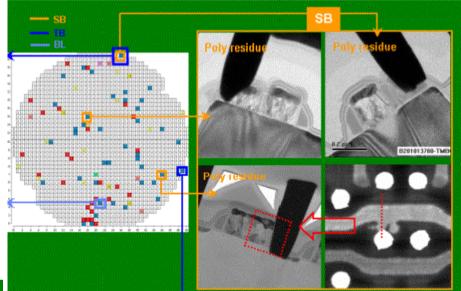




Solve It & Improve It.

- Defect reduction
- Process window characterization
- Process weakness
- Hardware control / PM / Lifetime
- Design improvement
- Innovation









- High Assets Utilization: Offload to utilize all Fabs at >85%, Serve the increasing customer demand and increase TJ revenue and margins.
- Reduced Lead time: To shorten Time to Market for New products → fuel our future Growth.
- Cost Reduction: OEE Improvement to reduce Capex investment. COGS Savings to increase Margins.
- Perfect Quality: Zero Field Returns, high Yields to retain the customers and win new products.





TowerJazz Investor and Analyst Day



CEO Summary

"Where were we", "where are we today" and "where should we be"?

Where were we?

- Manufacturing footprint limited to the "West" (MH, NPB).
- Customer base dominated by North America IDMs and fabless customers.

 Low fab utilization and negative profit.

Where are we today?

- Global manufacturing footprint with addition of TPSCo.
- Strong presence in APAC (~50%)

Higher utilization, we ARE profitable.

Where should we be in 5 years?

- More successful acquisitions (as Panasonic, Maxim), fab in China, 300mm included.
- Larger presence and manufacturing in China

 All available capacity at 85% utilization, in order to meet "\$1.5B financial model".



Closing Thoughts

"Leadership and learning are indispensible to each other." (John F. Kennedy)



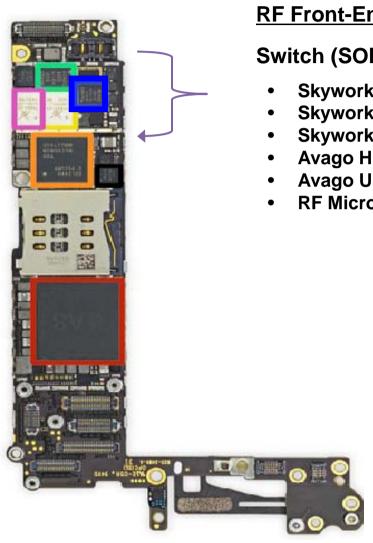


TowerJazz Investor and Analyst Day



Fab Tour Introduction

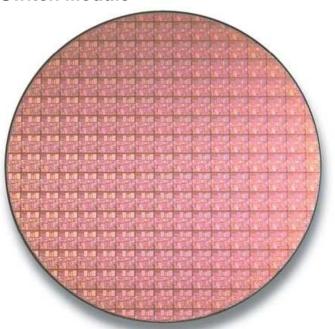
What are you going to see in the Fab? - What are we doing?



RF Front-End-Module content in iPhone6:

Switch (SOI), PA (GaAs, SiGe), Control (RF CMOS)

- Skyworks Low Band LTE PA
- Skyworks Mid Band LTE PA
- Skyworks Mid Band PA
- Avago High Band PA
- Avago Ultra High Band PA + FBARs
- RF Micro Devices Antenna Switch Module





The Clean Room

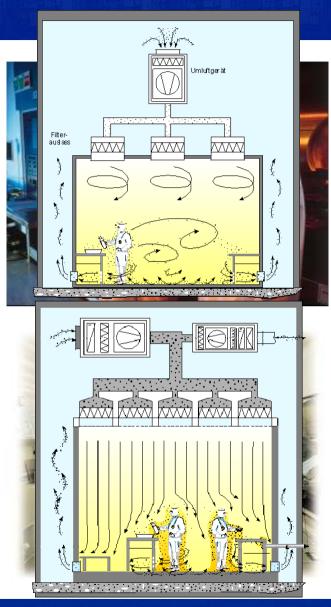
- Class 1 is defined as less than 1 particle with diameter larger than 0.5μ per cubic foot.
- Temperature/Humidity: A typical specification is 21 °C ±1 and 38% ±5% RH.

Water:

- 30 to 1: cost ratio to treat and discharge city water to ultra pure quality
- 4.8 million gallons of water used per day.
- 60,000: city population that can be served by the amount of water used.

Energy:

- 50% of total energy, used for HVAC in a semiconductor manufacturing facility
- 7500 houses use the equivalent amount of power needed for a typical fabrication plant.
- \$1M/Month typical monthly electric bill for large Fab.





What is a particle?

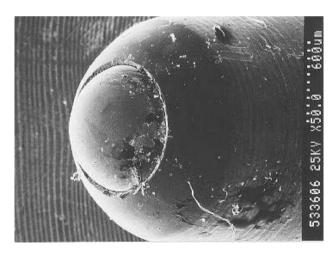
• Minute quantity of dust, or other material, not visible to the human eye



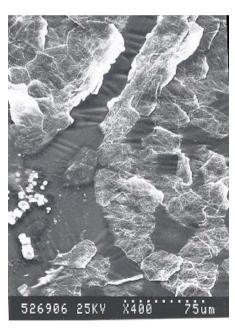


Other 0.5 microns

 Device yield and/or reliability can be affected by particles smaller than 1/10 of the minimum feature size



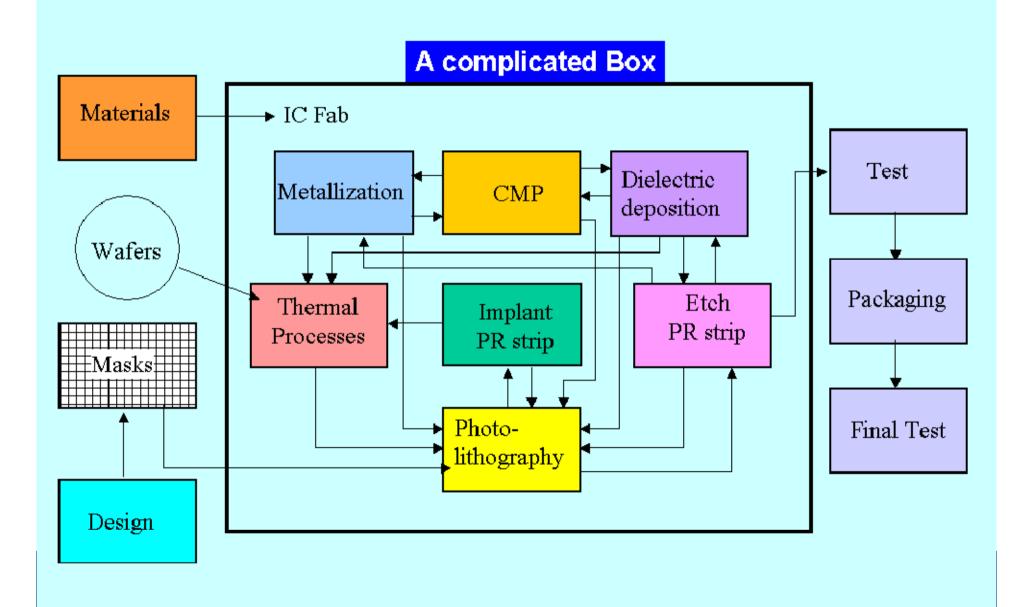
Ballpoint pen



Skin Flake

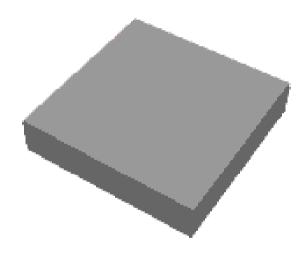


IC Manufacturing



Diffusion: Thermal Processes- Oxide Growth

- On the wafer, the first layer of **silicon dioxide** is grown by exposing it to extreme heat and gas.
- ➤ The silicon dioxide on the wafer, is too thin to be seen by the naked eye.





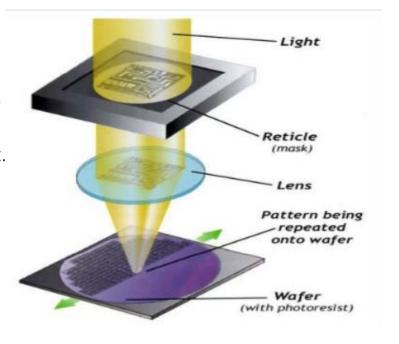
Si (Solid)
$$+O_2$$
 (Vapor) \rightarrow SiO₂ (Solid) Dry Oxidation
Si (Solid) $+H_2O$ (Vapor) \rightarrow SiO₂ (Solid) $+2H_2$ Wet Oxidation

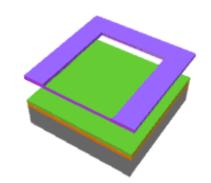


Photolithography Process

- The wafer is coated with Photo resist Material.
- The reticle containing a layer's image of one or more die are exposed by a UV light thought a lens system onto the wafer.
- The wafer is then stepped over to the next die and the process repeated until the wafer is completely exposed.
- Photo resist becomes soluble when exposed to ultraviolet light.





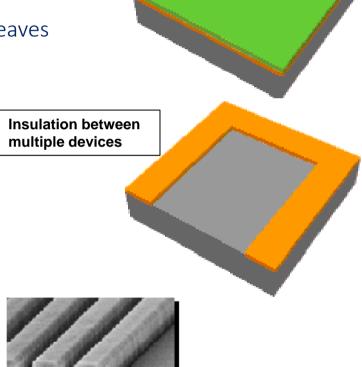




Etch & Strip

- The exposed PR is completely dissolved by a solvent.
- This reveals a pattern of PR made by the mask on the SiO₂
- The revealed SiO₂ is etched away with chemicals.
- The rest of the photo resist is removed. This process leaves ridges of silicon dioxide on the silicon wafer base.

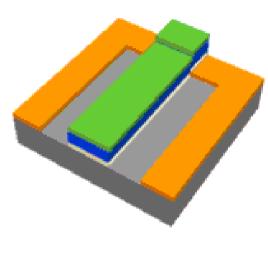


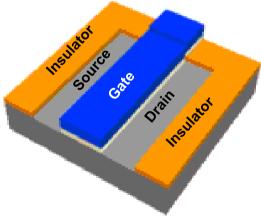




Building the Gate of the transistor

- The photo resist is dissolved with solvent to expose the polysilicon and silicon dioxide.
- Both are then etched away with chemicals.
- The remaining photo resist is removed, leaving ridges of polysilicon and silicon dioxide.

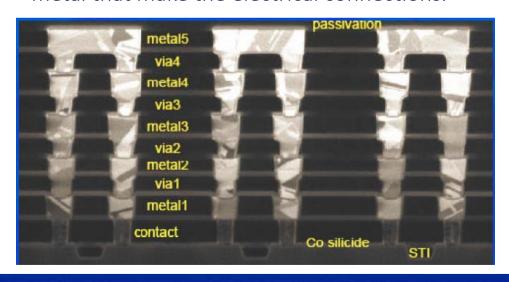


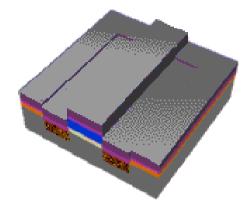


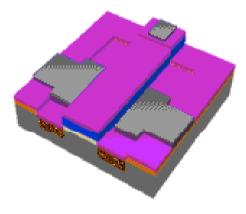


Layers upon Layers: Dielectric, Contact & Metal. Up to Six Metal layers.

- The layering and masking processes are repeated.
- Deposit Dielectric Layer (SiO2) to isolate between the Metal Layers.
- Creating windows that allow for connections to be made between the layers.
- Atoms of metal are deposited on the wafer, filling the windows.
- Another masking and etching stage leaves strips of the metal that make the electrical connections.

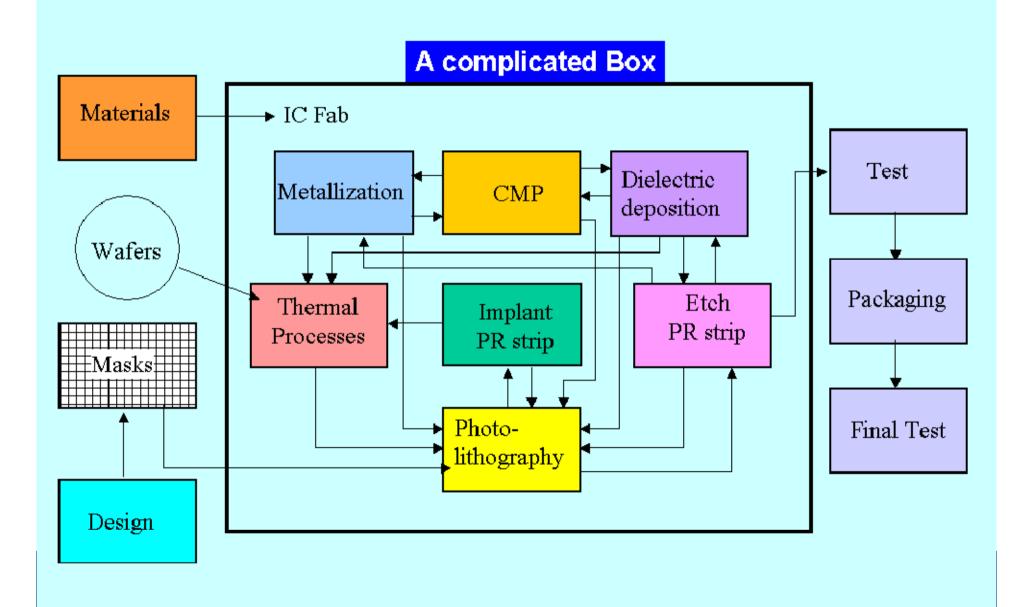








IC Manufacturing





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THANK YOU!

THEFILL WWW.towerjazz.com